

HM5117400A/AL Series

4,194,304-word × 4-bit Dynamic Random Access Memory

HITACHI

Rev. 3.0
Nov. 22, 1994

The Hitachi HM5117400A/AL is a CMOS dynamic RAM organized 4,194,304 word × 4 bit. It employs the most advanced CMOS technology for high performance and low power. The HM5117400A/AL offers Fast Page Mode as a high speed access mode.

Feature

- Single 5 V ($\pm 10\%$)
- High speed
 - Access time
60 ns/ 70 ns/ 80 ns (max)
- Low power dissipation
 - Active mode
605 mW/550 mW/495 mW(max)
 - Standby mode 11 mW (max)
0.83 mW (max) (L-version)
- Fast page mode capability
- Long refresh period
 - 2048 refresh cycles : 32 ms
128 ms (L-version)
- 3 variations of refresh
 - RAS-only refresh
 - $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh
 - Hidden refresh
- Battery backup operation (L-version)
- Test function
 - 16-bit parallel test mode

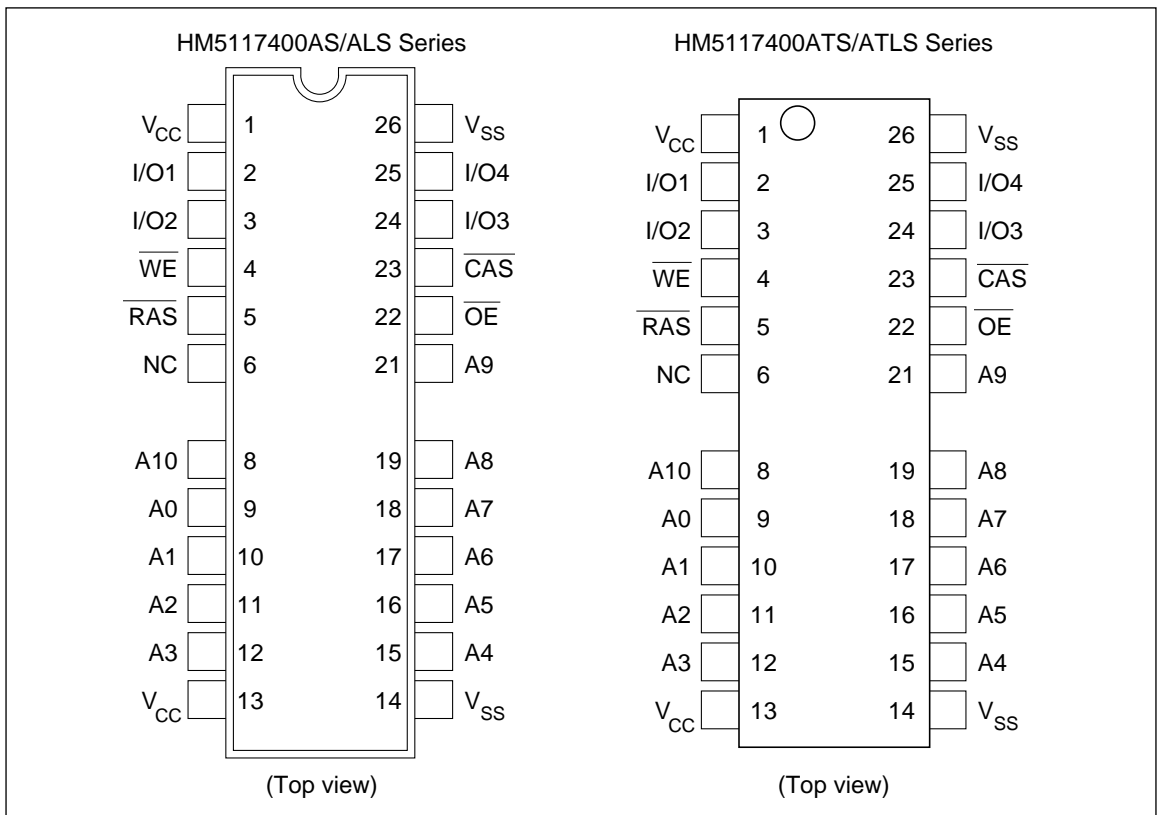
Ordering Information

Type No.	Access time	Package
HM5117400AS/ALS-6	60 ns	300-mil 26-pin
HM5117400AS/ALS-7	70 ns	plastic SOJ
HM5117400AS/ALS-8	80 ns	(CP-26/24DB)
HM5117400ATS/ALTS-6	60 ns	26-pin
HM5117400ATS/ALTS-7	70 ns	plastic TSOP II
HM5117400ATS/ALTS-8	80 ns	(TTP-26/24DA)

This specification is fully compatible with the 16-Mbit DRAM specifications from TEXAS INSTRUMENTS.

HM5117400A/AL Series

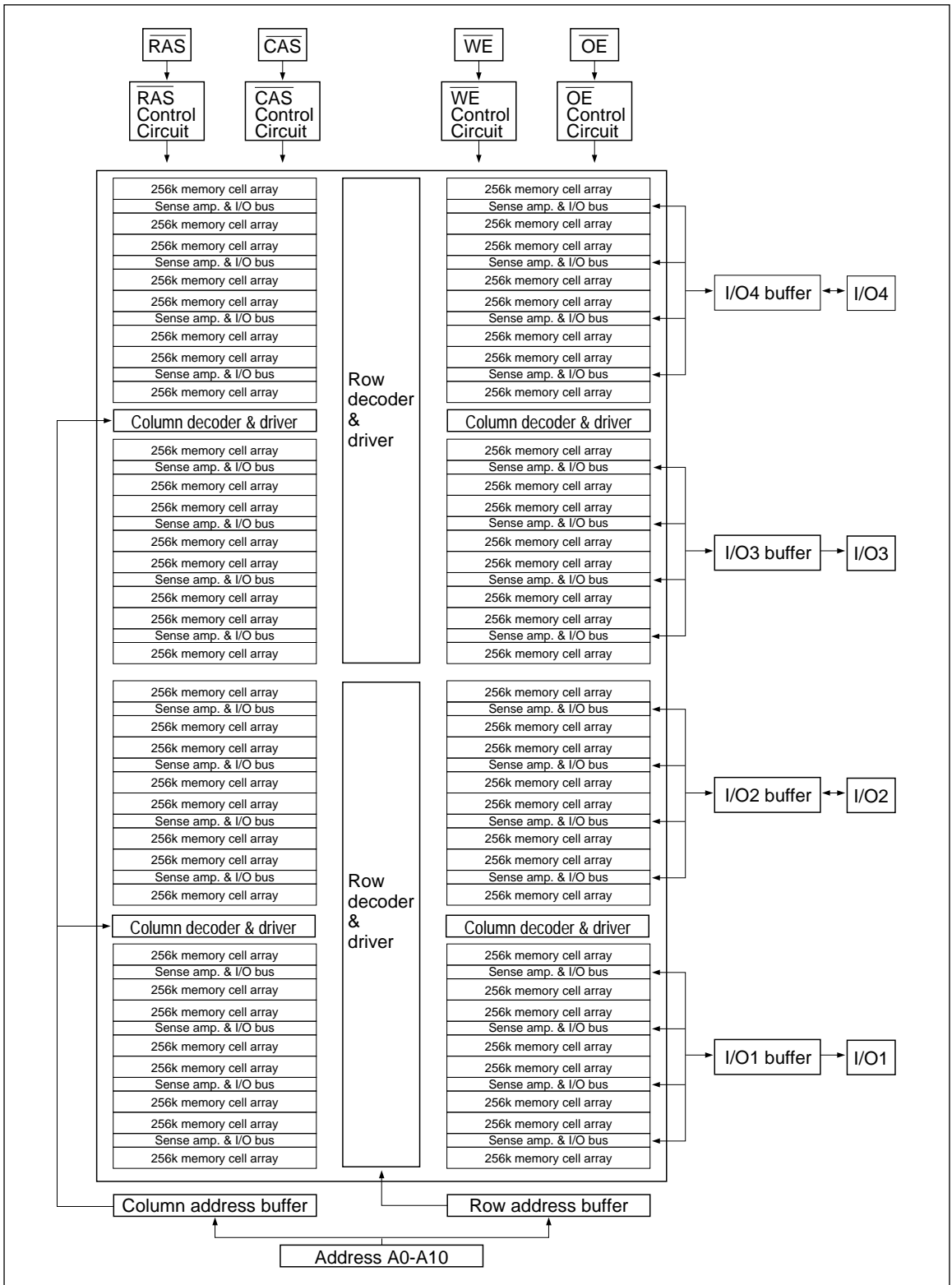
Pin Arrangement



Pin Description

Pin name	Function
A0 to A10	Address input
A0 to A10	Refresh address input
I/O0 to I/O4	Data input/data output
\overline{RAS}	Row address strobe
\overline{CAS}	Column address strobe
\overline{WE}	Write enable
\overline{OE}	Output enable
V _{CC}	Power supply (+5 V)
V _{SS}	Ground
NC	No connection

Block Diagram



HM5117400A/AL Series

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Voltage on any pin relative to V_{SS}	V_T	-1.0 to +7.0	V
Supply voltage relative to V_{SS}	V_{CC}	-1.0 to +7.0	V
Short circuit output current	I_{out}	50	mA
Power dissipation	P_T	1.0	W
Operating temperature	T_{opr}	0 to +70	°C
Storage temperature	T_{stg}	-55 to +125	°C

Recommended DC Operating Conditions ($T_a = 0$ to +70°C)

Parameter	Symbol	Min	Typ	Max	Unit	Note
Supply voltage	V_{CC}	4.5	5.0	5.5	V	1
Input high voltage	V_{IH}	2.4	—	6.5	V	1
Input low voltage	V_{IL}	-1.0	—	0.8	V	1

Note: 1. All voltage referred to V_{SS}

DC Characteristics (Ta = 0 to +70°C, VCC = 5 V ± 10%, VSS = 0 V)

Parameter	Symbol	HM5117400A/AL						Unit	Test conditions	Notes
		-6		-7		-8				
		Min	Max	Min	Max	Min	Max			
Operating current	ICC1	—	110	—	100	—	90	mA	tRC = min	1, 2
Standby current	ICC2	—	2	—	2	—	2	mA	TTL interface RAS, CAS = VIH Dout = High-Z	
		—	1	—	1	—	1	mA	CMOS interface RAS, CAS ≥ VCC – 0.2V Dout = High-Z	
Standby current (L-version)	ICC2	—	150	—	150	—	150	µA	CMOS interface RAS, CAS ≥ VCC – 0.2V Dout = High-Z	
RAS-only refresh current	ICC3	—	110	—	100	—	90	mA	tRC = min	2
Standby current	ICC5	—	5	—	5	—	5	mA	RAS = VIH CAS = VIL Dont = enable	1
CAS-before-RAS refresh current	ICC6	—	110	—	100	—	90	mA	tRC = min	
Fast page mode current	ICC7	—	80	—	70	—	65	mA	tPC = min	1, 3
Battery back up current	ICC10	—	350	—	350	—	350	µA	CMOS interface Dout = High-Z CBR refresh: tRC = 62.5 µs tRAS ≤ 0.3 µs	4
Input leakage current	ILI	–10	10	–10	10	–10	10	µA	0 V ≤ Vin ≤ 7 V	
Output leakage current	ILO	–10	10	–10	10	–10	10	µA	0 V ≤ Vout ≤ 7 V Dout = disable	
Output high voltage	VOH	2.4	VCC	2.4	VCC	2.4	VCC	V	High Iout = –5 mA	
Output low voltage	VOL	0	0.4	0	0.4	0	0.4	V	Low Iout = 4.2 mA	

- Notes: 1. ICC depends on output load condition when the device is selected. ICC max is specified at the output open condition.
 2. Address can be changed once or less while RAS = VIL.
 3. Address can be changed once or less while CAS = VIH.
 4. CAS = L (≤ 0.2 V) while RAS = L (≤ 0.2 V).

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Capacitance ($T_a = 25^\circ\text{C}$, $V_{CC} = 5\text{ V} \pm 10\%$)

Parameter	Symbol	Typ	Max	Unit	Notes
Input capacitance (Address)	C_{I1}	—	5	pF	1
Input capacitance (Clocks)	C_{I2}	—	7	pF	1
Output capacitance (Data-in, Data-out)	$C_{I/O}$	—	7	pF	1, 2

Notes: 1. Capacitance measured with Boonton Meter or effective capacitance measuring method.
2. $\overline{\text{CAS}} = V_{IH}$ to disable Dout.

AC Characteristics ($T_a = 0$ to $+70^\circ\text{C}$, $V_{CC} = 5\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$) *1, *2, *18, *19

Test Conditions

- Input rise and fall times : 5 ns
- Input timing reference levels : 0.8 V, 2.4 V
- Output load : 2 TTL gate + C_L (100 pF) (Including scope and jig)

Read, Write, Read-Modify-Write and Refresh Cycles (Common parameters)

Parameter	Symbol	HM5117400A/AL						Unit	Notes
		-6		-7		-8			
		Min	Max	Min	Max	Min	Max		
Random read or write cycle time	t _{RC}	110	—	130	—	150	—	ns	
$\overline{\text{RAS}}$ precharge time	t _{RP}	40	—	50	—	60	—	ns	
$\overline{\text{CAS}}$ precharge time	t _{CP}	10	—	10	—	10	—	ns	
$\overline{\text{RAS}}$ pulse width	t _{RAS}	60	10000	70	10000	80	10000	ns	
$\overline{\text{CAS}}$ pulse width	t _{CAS}	15	10000	18	10000	20	10000	ns	
Row address setup time	t _{ASR}	0	—	0	—	0	—	ns	
Row address hold time	t _{RAH}	10	—	10	—	10	—	ns	
Column address setup time	t _{ASC}	0	—	0	—	0	—	ns	
Column address hold time	t _{CAH}	10	—	15	—	15	—	ns	
$\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ delay time	t _{RCD}	20	45	20	52	20	60	ns	3
$\overline{\text{RAS}}$ to column address delay time	t _{RAD}	15	30	15	35	15	40	ns	4
$\overline{\text{RAS}}$ hold time	t _{RSH}	15	—	18	—	20	—	ns	
$\overline{\text{CAS}}$ hold time	t _{CSH}	60	—	70	—	80	—	ns	
$\overline{\text{CAS}}$ to $\overline{\text{RAS}}$ precharge time	t _{CRP}	5	—	5	—	5	—	ns	
$\overline{\text{OE}}$ to Din delay time	t _{OED}	15	—	18	—	20	—	ns	5
$\overline{\text{OE}}$ delay time from Din	t _{DZO}	0	—	0	—	0	—	ns	6
$\overline{\text{CAS}}$ delay time from Din	t _{DZC}	0	—	0	—	0	—	ns	6
Transition time (rise and fall)	t _T	3	50	3	50	3	50	ns	7

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Read Cycle

Parameter	Symbol	HM5117400A/AL						Unit	Notes
		-6		-7		-8			
		Min	Max	Min	Max	Min	Max		
Access time from $\overline{\text{RAS}}$	t_{RAC}	—	60	—	70	—	80	ns	8, 9, 20
Access time from $\overline{\text{CAS}}$	t_{CAC}	—	15	—	18	—	20	ns	9, 10, 17, 20
Access time from address	t_{AA}	—	30	—	35	—	40	ns	9, 11, 17, 20
Access time from $\overline{\text{OE}}$	t_{OEA}	—	15	—	18	—	20	ns	9, 20
Read command setup time	t_{RCS}	0	—	0	—	0	—	ns	
Read command hold time to $\overline{\text{CAS}}$	t_{RCH}	0	—	0	—	0	—	ns	12
Read command hold time to $\overline{\text{RAS}}$	t_{RRH}	0	—	0	—	0	—	ns	12
Column address to $\overline{\text{RAS}}$ lead time	t_{RAL}	30	—	35	—	40	—	ns	
Column address to $\overline{\text{CAS}}$ lead time	t_{CAL}	30	—	35	—	40	—	ns	
$\overline{\text{CAS}}$ to output in low-Z	t_{CLZ}	0	—	0	—	0	—	ns	
Output data hold time	t_{OH}	3	—	3	—	3	—	ns	
Output data hold time from $\overline{\text{OE}}$	t_{OHO}	3	—	3	—	3	—	ns	
Output buffer turn-off time	t_{OFF}	—	15	—	15	—	15	ns	13
Output buffer turn-off to $\overline{\text{OE}}$	t_{OEZ}	—	15	—	15	—	15	ns	13
$\overline{\text{CAS}}$ to Din delay time	t_{CDD}	15	—	18	—	20	—	ns	5

Write Cycle

Parameter	Symbol	HM5117400A/AL						Unit	Notes
		-6		-7		-8			
		Min	Max	Min	Max	Min	Max		
Write command setup time	t_{WCS}	0	—	0	—	0	—	ns	14
Write command hold time	t_{WCH}	10	—	15	—	15	—	ns	
Write command pulse width	t_{WP}	10	—	10	—	10	—	ns	
Write command to $\overline{\text{RAS}}$ lead time	t_{RWL}	15	—	18	—	20	—	ns	
Write command to $\overline{\text{CAS}}$ lead time	t_{CWL}	15	—	18	—	20	—	ns	
Data-in setup time	t_{DS}	0	—	0	—	0	—	ns	15
Data-in hold time	t_{DH}	10	—	15	—	15	—	ns	15

Read-Modify-Write Cycle

Parameter	Symbol	HM5117400A/AL						Unit	Notes
		-6		-7		-8			
		Min	Max	Min	Max	Min	Max		
Read-modify-write cycle time	t _{RWC}	155	—	181	—	205	—	ns	
$\overline{\text{RAS}}$ to $\overline{\text{WE}}$ delay time	t _{RWD}	85	—	98	—	110	—	ns	14
$\overline{\text{CAS}}$ to $\overline{\text{WE}}$ delay time	t _{CWD}	40	—	46	—	50	—	ns	14
Column address to $\overline{\text{WE}}$ delay time	t _{AWD}	55	—	63	—	70	—	ns	14
$\overline{\text{OE}}$ hold time from $\overline{\text{WE}}$	t _{OEH}	15	—	18	—	20	—	ns	

Refresh Cycle

Parameter	Symbol	HM5117400A/AL						Unit	Notes
		-6		-7		-8			
		Min	Max	Min	Max	Min	Max		
$\overline{\text{CAS}}$ setup time (CBR refresh cycle)	t _{CSR}	5	—	5	—	5	—	ns	
$\overline{\text{CAS}}$ hold time (CBR refresh cycle)	t _{CHR}	10	—	10	—	10	—	ns	
$\overline{\text{WE}}$ setup time (CBR refresh cycle)	t _{WRP}	0	—	0	—	0	—	ns	
$\overline{\text{WE}}$ hold time (CBR refresh cycle)	t _{WRH}	10	—	10	—	10	—	ns	
$\overline{\text{RAS}}$ precharge to $\overline{\text{CAS}}$ hold time	t _{RPC}	0	—	0	—	0	—	ns	

Fast Page Mode Cycle

Parameter	Symbol	HM5117400A/AL						Unit	Notes
		-6		-7		-8			
		Min	Max	Min	Max	Min	Max		
Fast page mode cycle time	t _{PC}	40	—	45	—	50	—	ns	
Fast page mode $\overline{\text{RAS}}$ pulse width	t _{RASP}	—	100000	—	100000	—	100000	ns	16
Access time from $\overline{\text{CAS}}$ precharge	t _{CPA}	—	35	—	40	—	45	ns	9, 17, 20
$\overline{\text{RAS}}$ hold time from $\overline{\text{CAS}}$ precharge	t _{CPRH}	35	—	40	—	45	—	ns	

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Fast Page Mode Read-Modify-Write Cycle

Parameter	Symbol	HM5117400A/AL						Unit	Notes
		-6		-7		-8			
		Min	Max	Min	Max	Min	Max		
Fast page mode read-modify-write cycle time	t _{PRWC}	85	—	96	—	105	—	ns	
$\overline{\text{WE}}$ delay time from $\overline{\text{CAS}}$ precharge	t _{CPW}	60	—	68	—	75	—	ns	14

Test Mode Cycle *20

Parameter	Symbol	HM5117400A/AL						Unit	Notes
		-6		-7		-8			
		Min	Max	Min	Max	Min	Max		
Test mode $\overline{\text{WE}}$ setup time	t _{WTS}	0	—	0	—	0	—	ns	
Test mode $\overline{\text{WE}}$ hold time	t _{WTH}	10	—	10	—	10	—	ns	

Counter Test Cycle

Parameter	Symbol	HM5117400A/AL						Unit	Notes
		-6		-7		-8			
		Min	Max	Min	Max	Min	Max		
$\overline{\text{CAS}}$ precharge time in counter test cycle	t _{CPT}	20	—	30	—	30	—	ns	

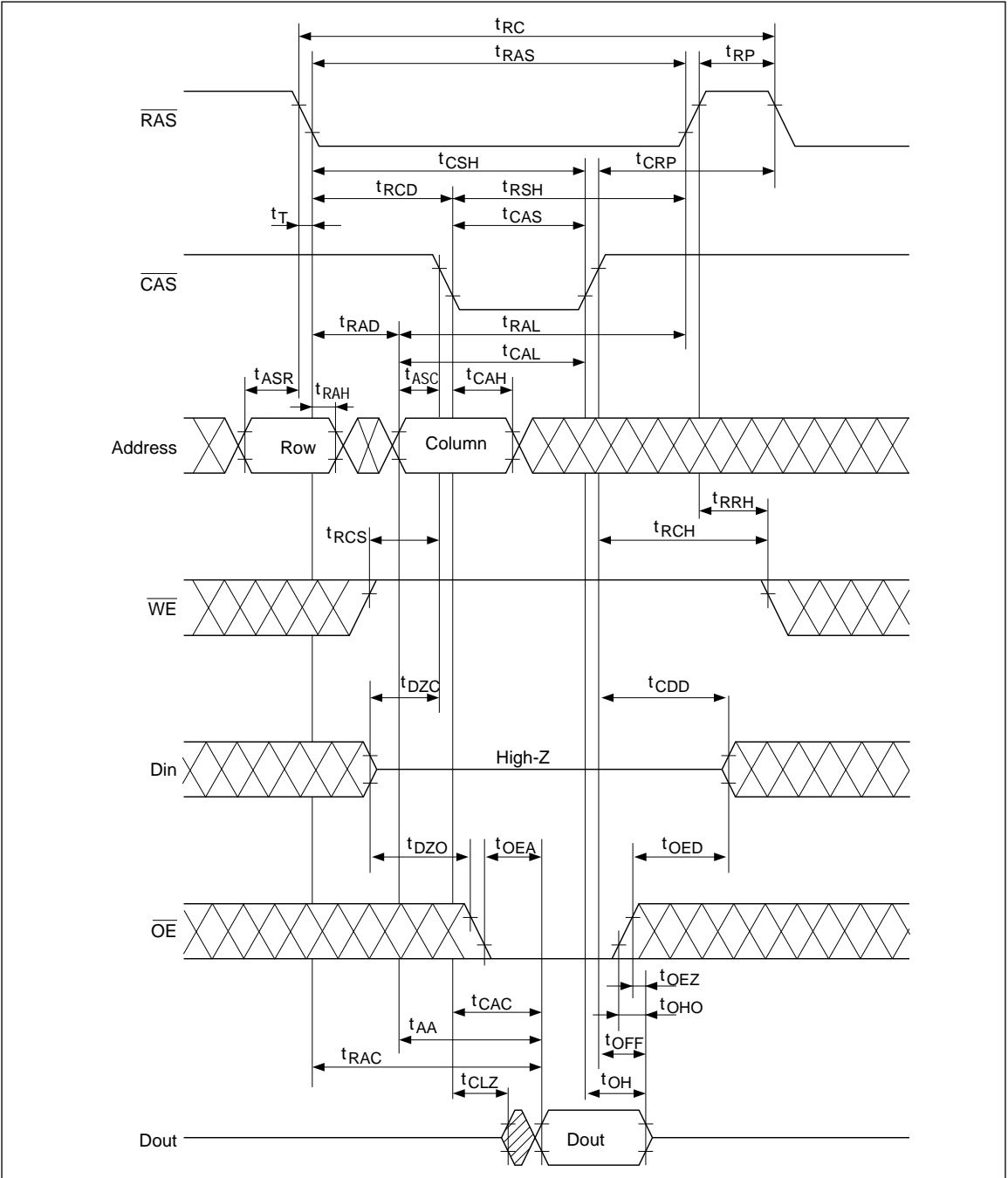
Refresh

Parameter	Symbol	Max	Unit	Note
Refresh period	t _{REF}	32	ms	2048 cycles
Refresh period (L-version)	t _{REF}	128	ms	2048 cycles

- Notes:
1. AC measurements assume $t_T = 5$ ns.
 2. An initial pause of 200 μ s is required after power up followed by a minimum of eight initialization cycles (any combination of cycles containing $\overline{\text{RAS}}$ -only refresh or $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh). If the internal refresh counter is used, a minimum of eight $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh cycles are required.
 3. Operation with the t_{RCD} (max) limit insures that t_{RAC} (max) can be met, t_{RCD} (max) is specified as a reference point only; if t_{RCD} is greater than the specified t_{RCD} (max) limit, then access time is controlled exclusively by t_{CAC} .
 4. Operation with the t_{RAD} (max) limit insures that t_{RAC} (max) can be met, t_{RAD} (max) is specified as a reference point only; if t_{RAD} is greater than the specified t_{RAD} (max) limit, then access time is controlled exclusively by t_{AA} .
 5. Either t_{OED} or t_{CDD} must be satisfied.
 6. Either t_{DZO} or t_{DZC} must be satisfied.
 7. V_{IH} (min) and V_{IL} (max) are reference levels for measuring timing of input signals. Also, transition times are measured between V_{IH} (min) and V_{IL} (max).
 8. Assumes that $t_{\text{RCD}} \leq t_{\text{RCD}}$ (max) and $t_{\text{RAD}} \leq t_{\text{RAD}}$ (max). If t_{RCD} or t_{RAD} is greater than the maximum recommended value shown in this table, t_{RAC} exceeds the value shown.
 9. Measured with a load circuit equivalent to 2 TTL loads and 100 pF.
 10. Assumes that $t_{\text{RCD}} \geq t_{\text{RCD}}$ (max) and $t_{\text{RAD}} \leq t_{\text{RAD}}$ (max).
 11. Assumes that $t_{\text{RCD}} \leq t_{\text{RCD}}$ (max) and $t_{\text{RAD}} \geq t_{\text{RAD}}$ (max).
 12. Either t_{RCH} or t_{RRH} must be satisfied for a read cycles.
 13. t_{OFF} (max) and t_{OEZ} (max) define the time at which the outputs achieve the open circuit condition and are not referenced to output voltage levels.
 14. t_{WCS} , t_{RWD} , t_{CWD} , t_{AWD} and t_{CPW} are not restrictive operating parameters. They are included in the data sheet as electrical characteristics only; if $t_{\text{WCS}} \geq t_{\text{WCS}}$ (min), the cycle is an early write cycle and the data out pin will remain open circuit (high impedance) throughout the entire cycle; if $t_{\text{RWD}} \geq t_{\text{RWD}}$ (min), $t_{\text{CWD}} \geq t_{\text{CWD}}$ (min), and $t_{\text{AWD}} \geq t_{\text{AWD}}$ (min), or $t_{\text{CWD}} \geq t_{\text{CWD}}$ (min), $t_{\text{AWD}} \geq t_{\text{AWD}}$ (min) and $t_{\text{CPW}} \geq t_{\text{CPW}}$ (min), the cycle is a read-modify-write and the data output will contain data read from the selected cell; if neither of the above sets of conditions is satisfied, the condition of the data out (at access time) is indeterminate.
 15. These parameters are referenced to $\overline{\text{CAS}}$ leading edge in early write cycles and to $\overline{\text{WE}}$ leading edge in delayed write or read-modify-write cycles.
 16. t_{RASP} defines $\overline{\text{RAS}}$ pulse width in fast page mode cycles.
 17. Access time is determined by the longer of t_{AA} or t_{CAC} or t_{CPA} .
 18. In delayed write or read-modify-write cycles, $\overline{\text{OE}}$ must disable output buffer prior to applying data to the device. After $\overline{\text{RAS}}$ is reset, if $t_{\text{OEH}} \geq t_{\text{CWL}}$, the I/O pin will remain open circuit (high impedance); if $t_{\text{OEH}} \leq t_{\text{CWL}}$, invalid data will be out at each I/O.
 19. The 16M DRAM offers a 16-bits time saving parallel test mode. Address CA0 and CA1 for the $4\text{M} \times 4$ are don't care during test mode. Test mode is set by performing $\overline{\text{WE}}$ -and- $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ (WCBR) cycle. In 16-bits parallel test mode, data is written into 4 bits in parallel at each I/O (I/O1 to I/O4) and read out from each I/O.
 If 4 bits of each I/O are equal (all 1s or 0s), data output pin is a high state during test mode read cycle, then the device has passed. If they are not equal, data output pin is a low state, then the device has failed.
 Refresh during test mode operation can be performed by normal read cycles or by WCBR refresh cycles.
 To get out of test mode and enter a normal operation mode, perform either a regular $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh cycle or $\overline{\text{RAS}}$ -only refresh cycle.
 20. In a test mode read cycle, the value of t_{RAC} , t_{AA} , t_{CAC} and t_{CPA} is delayed by 2 ns to 5 ns for the specified value. These parameters should be specified in test mode cycles by adding the above value to the specified value in this data sheet.

Timing Waveforms#21

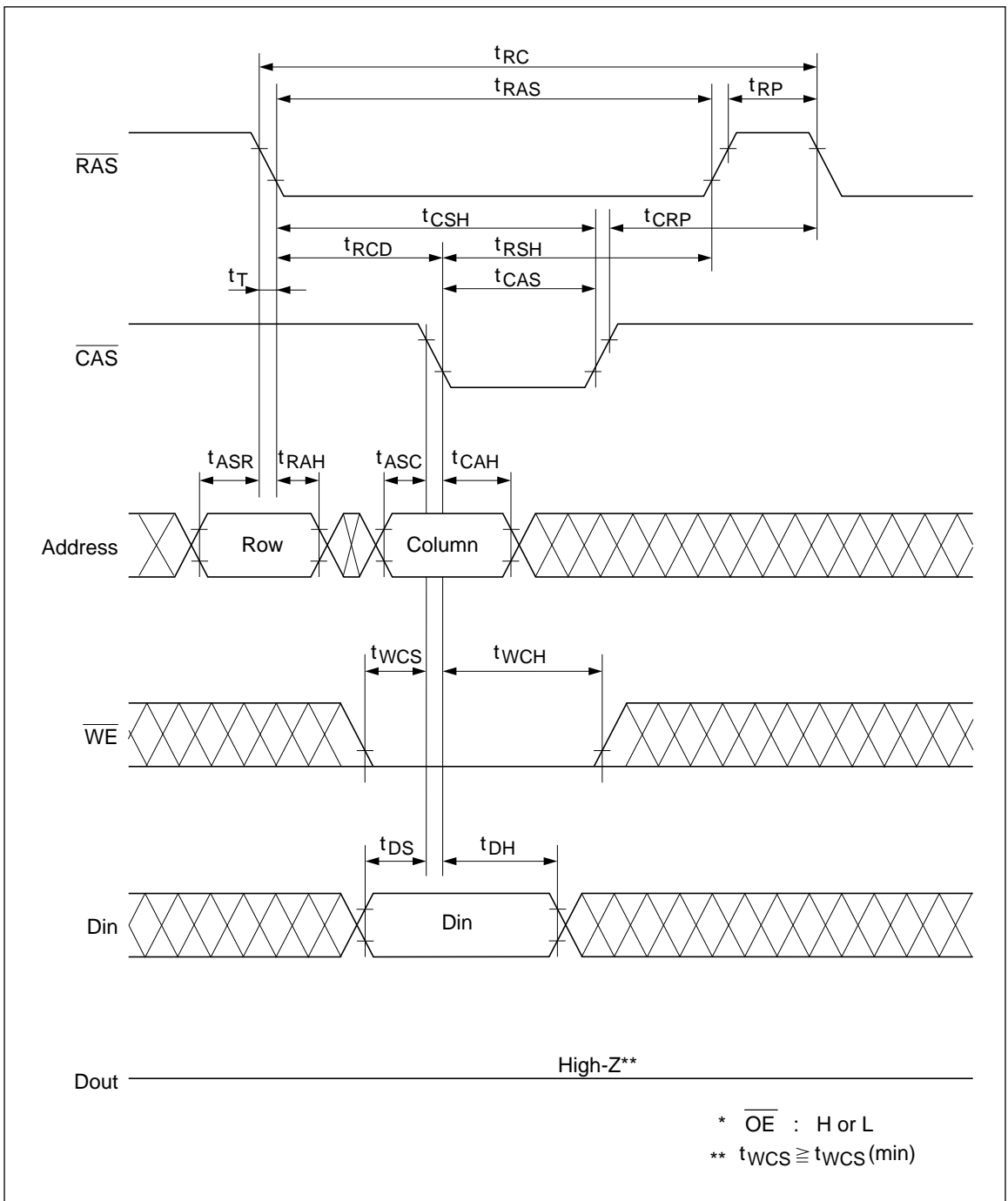
Read Cycle



Notes: 21. H or L (H: $V_{IH}(\min) \leq V_{IN} \leq V_{IH}(\max)$, L: $V_{IL}(\min) \leq V_{IN} \leq V_{IL}(\max)$)

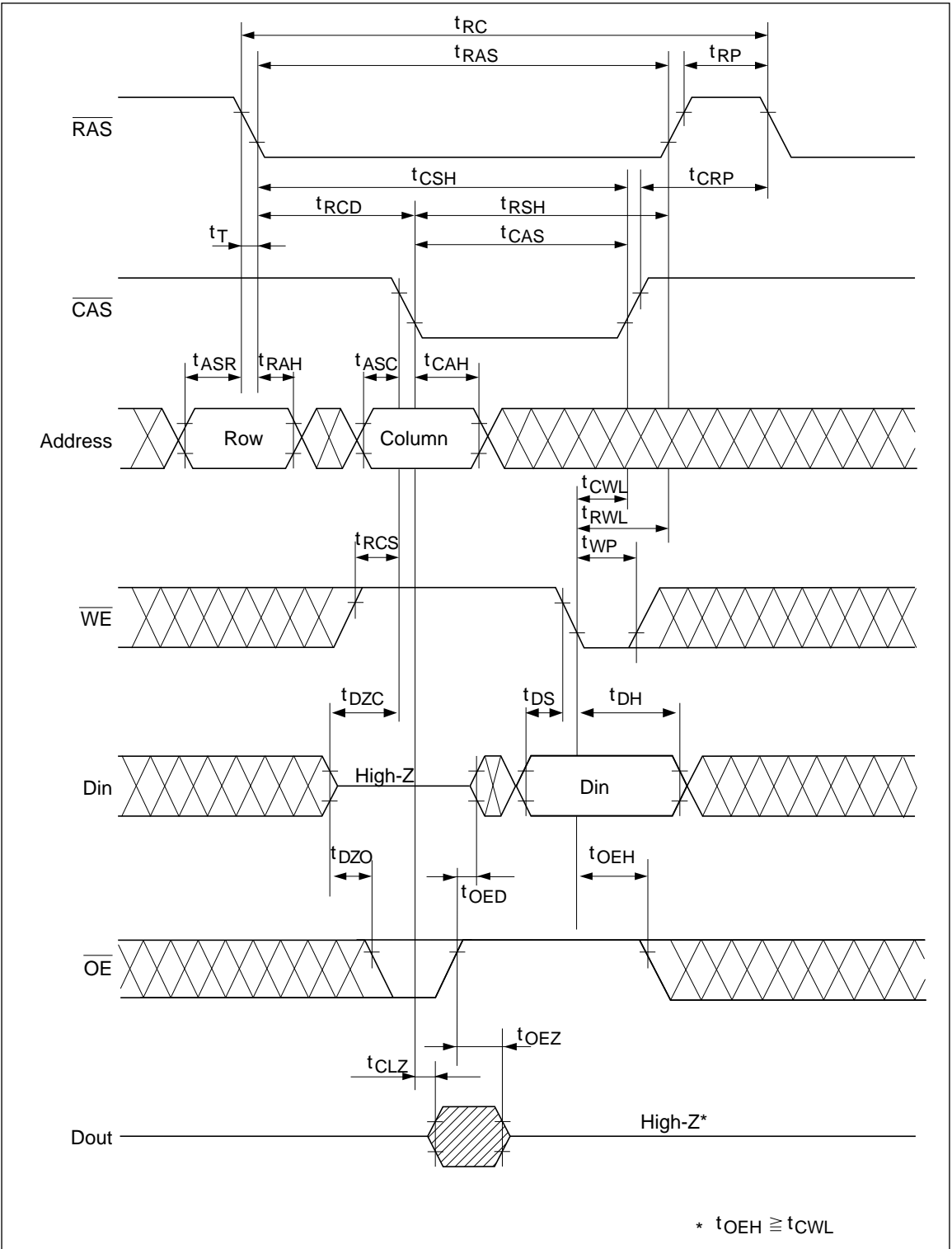
Invalid Dout

Early Write Cycle

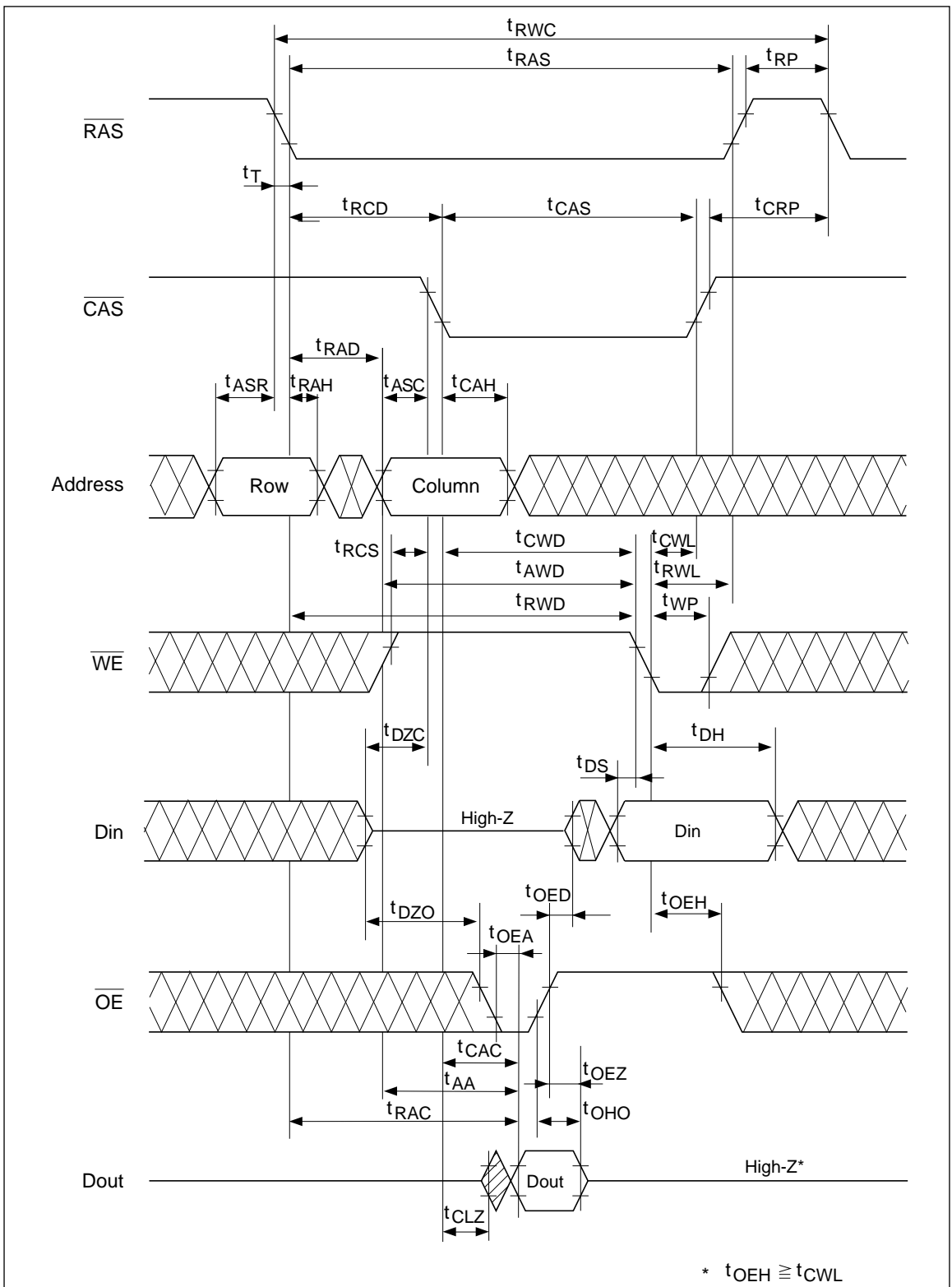


HM5117400A/AL Series

Delayed Write Cycle *18

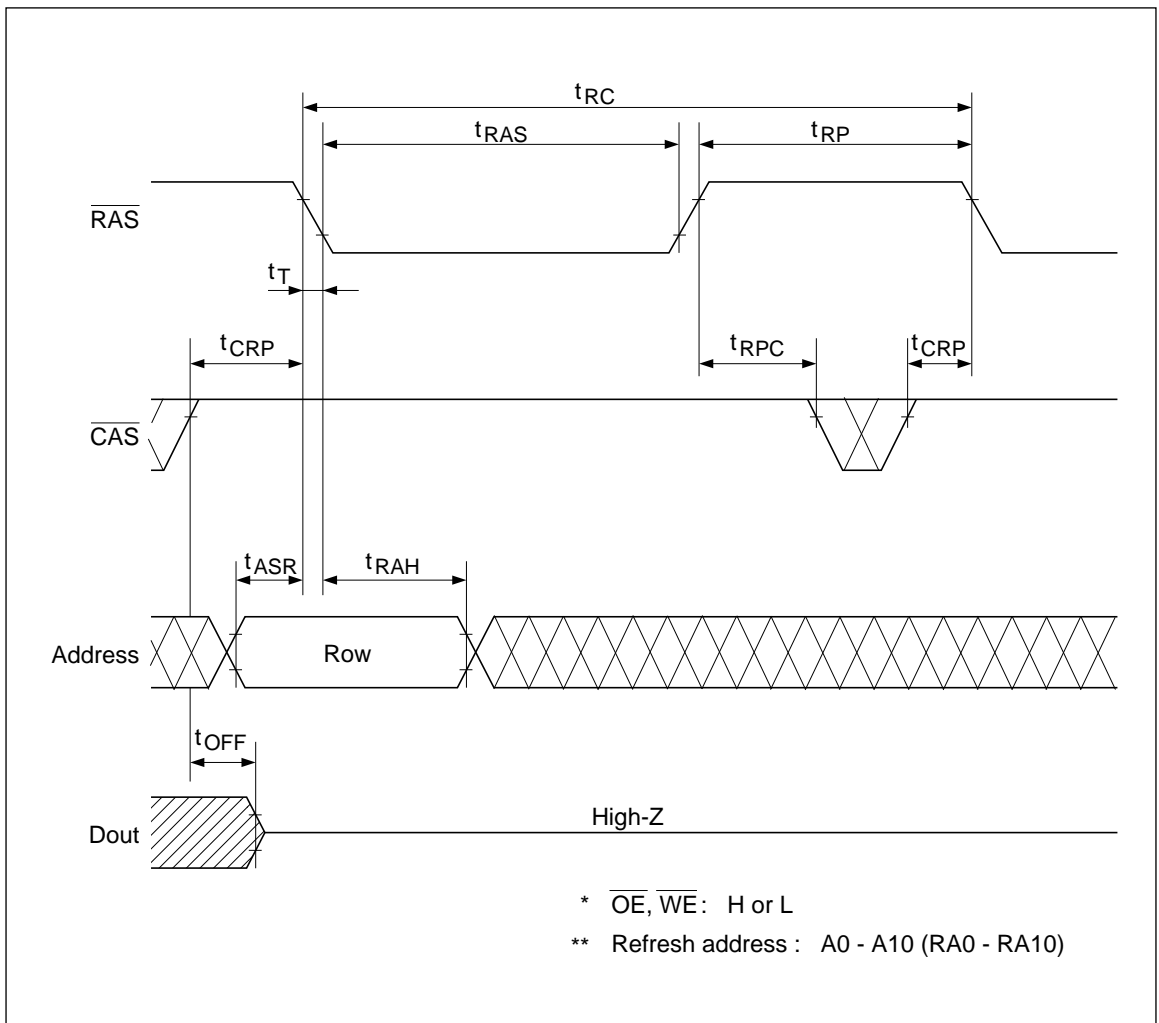


Read-Modify-Write Cycle *18



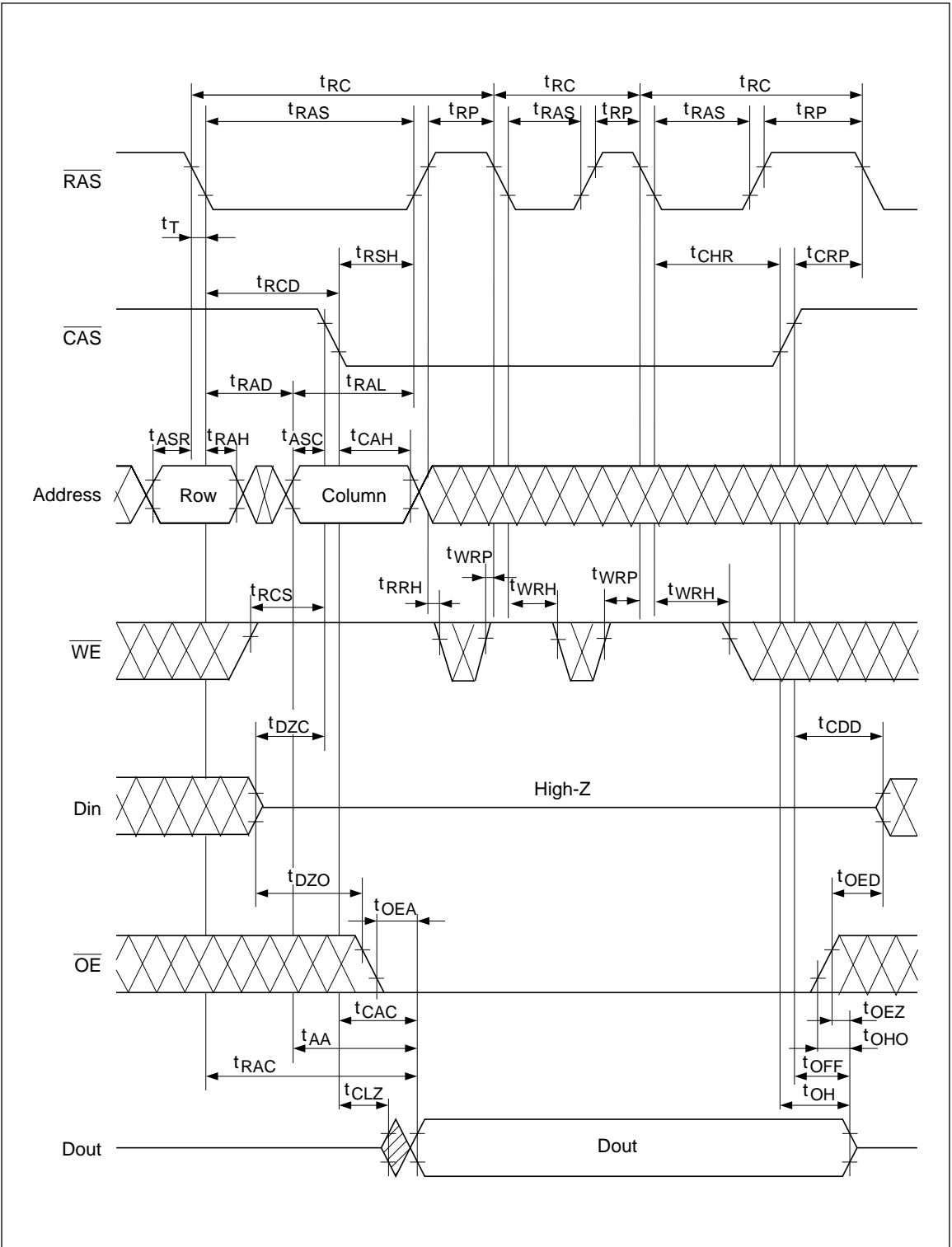
HM5117400A/AL Series

$\overline{\text{RAS}}$ -Only Refresh Cycle

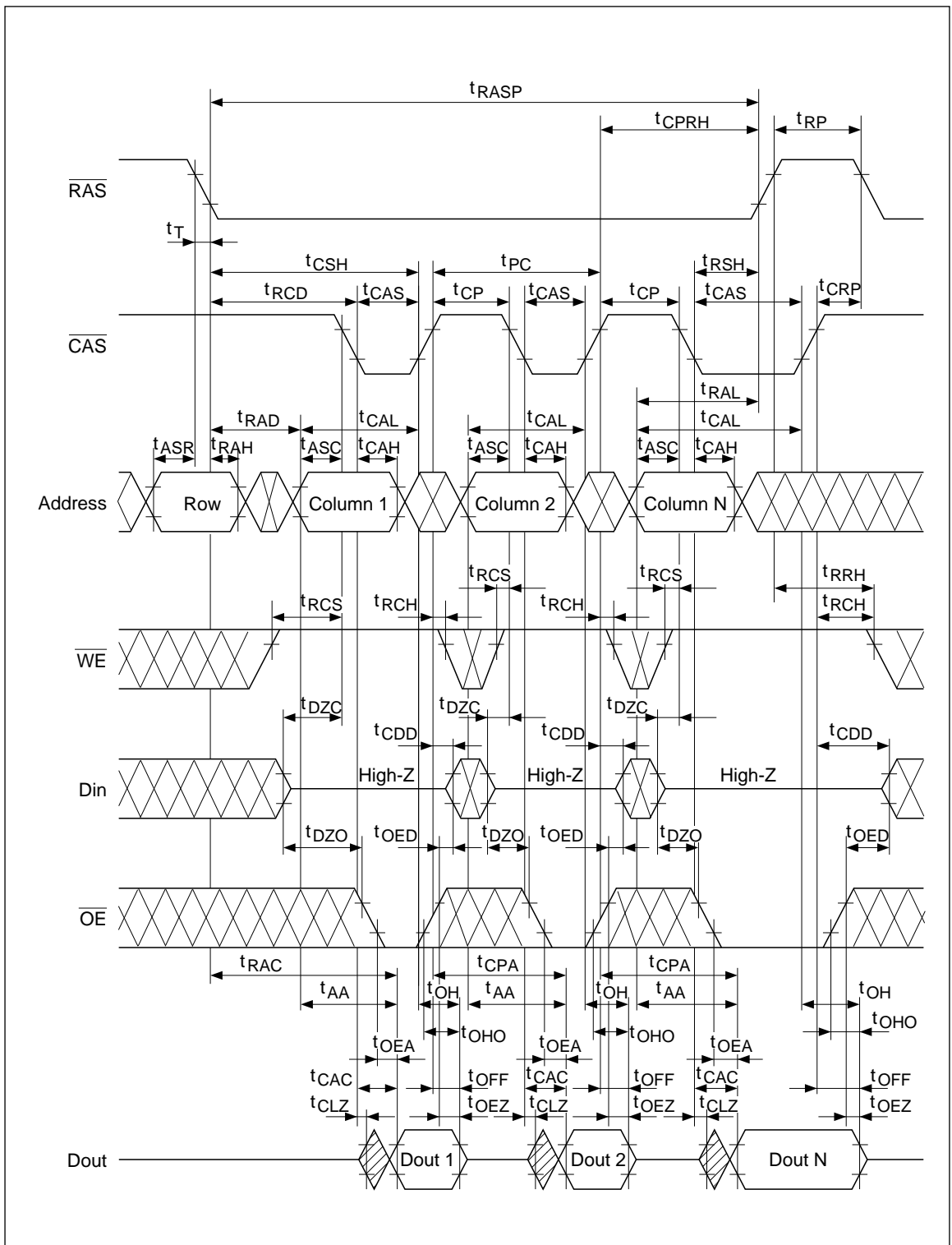


HM5117400A/AL Series

Hidden Refresh Cycle

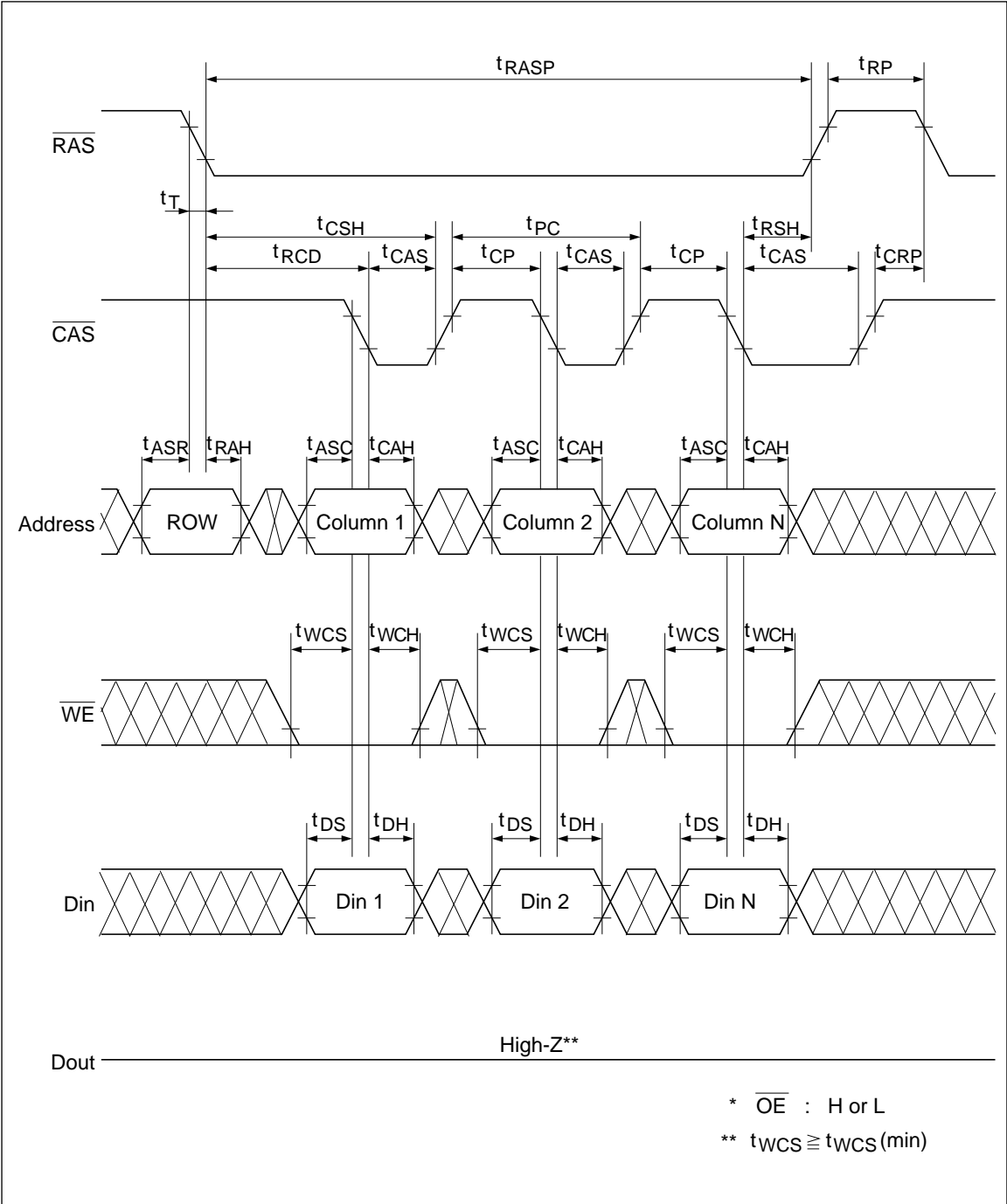


Fast Page Mode Read Cycle



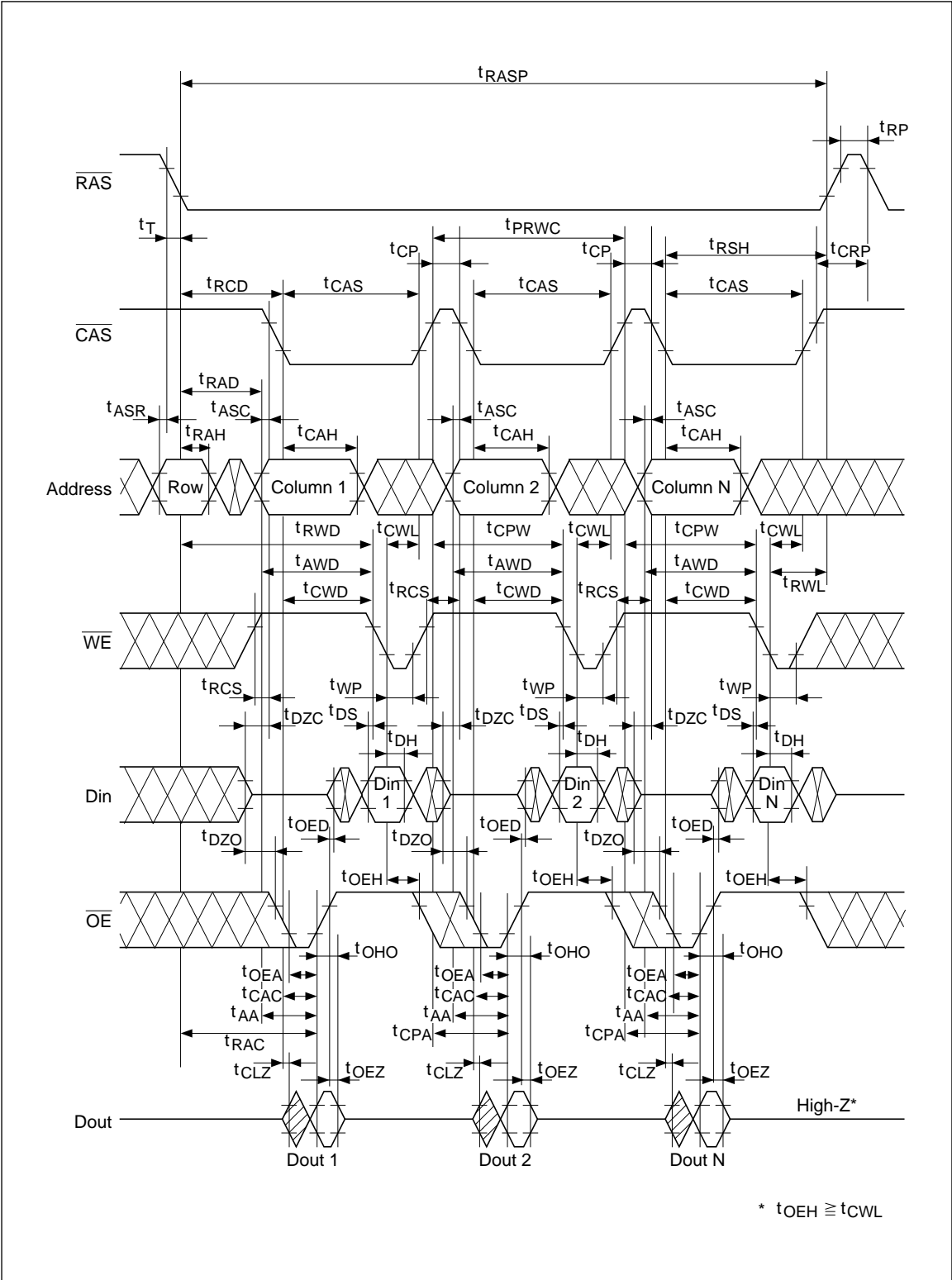
HM5117400A/AL Series

Fast Page Mode Early Write Cycle

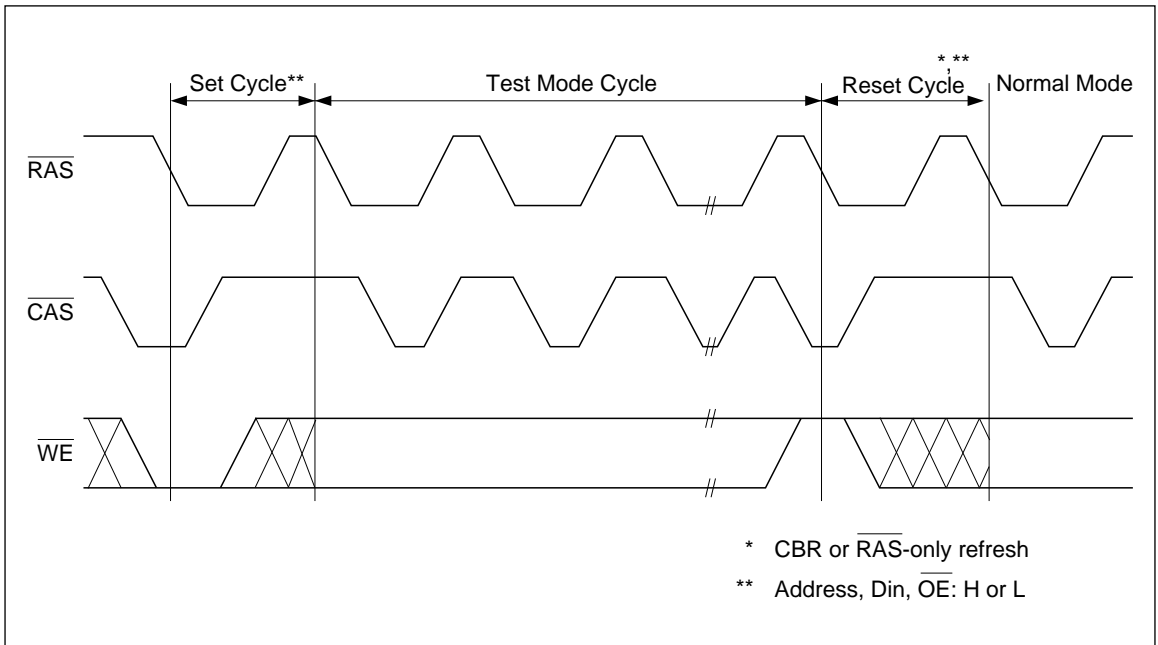


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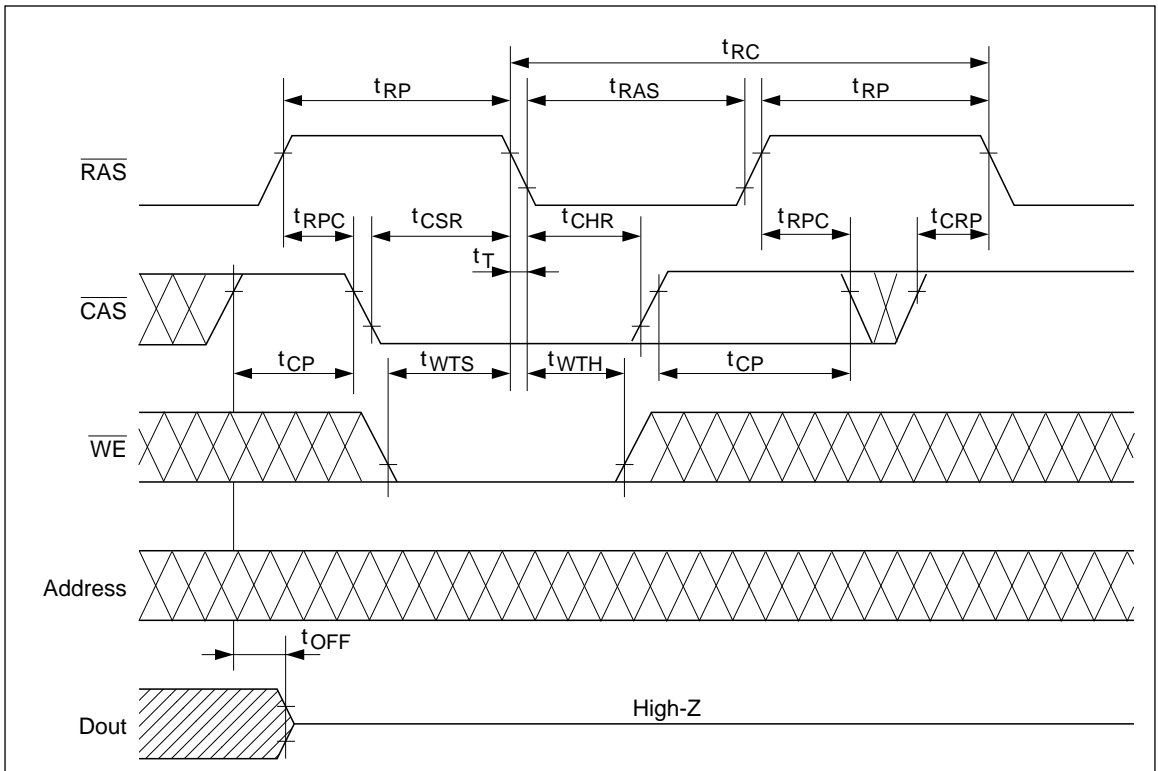
Fast Page Mode Read-Modify-Write Cycle *18



Test Mode Cycle *19



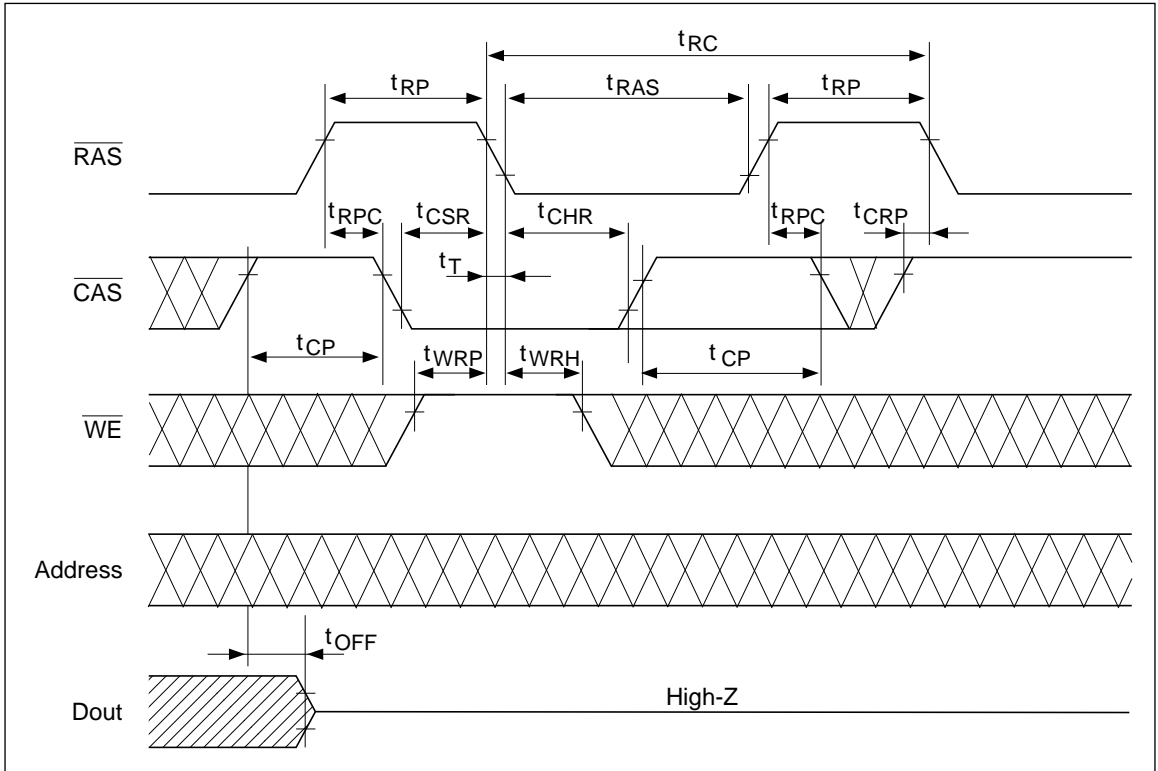
Test Mode Set Cycle



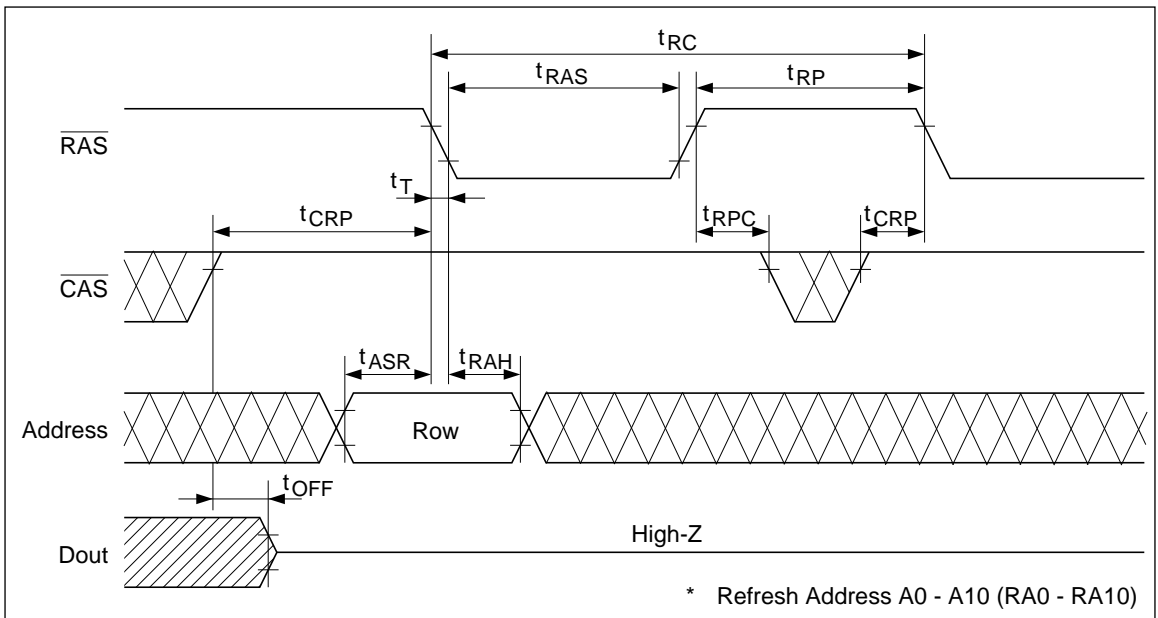
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Test Mode Reset Cycle

$\overline{\text{CAS}}$ -Before- $\overline{\text{RAS}}$ Refresh Cycle

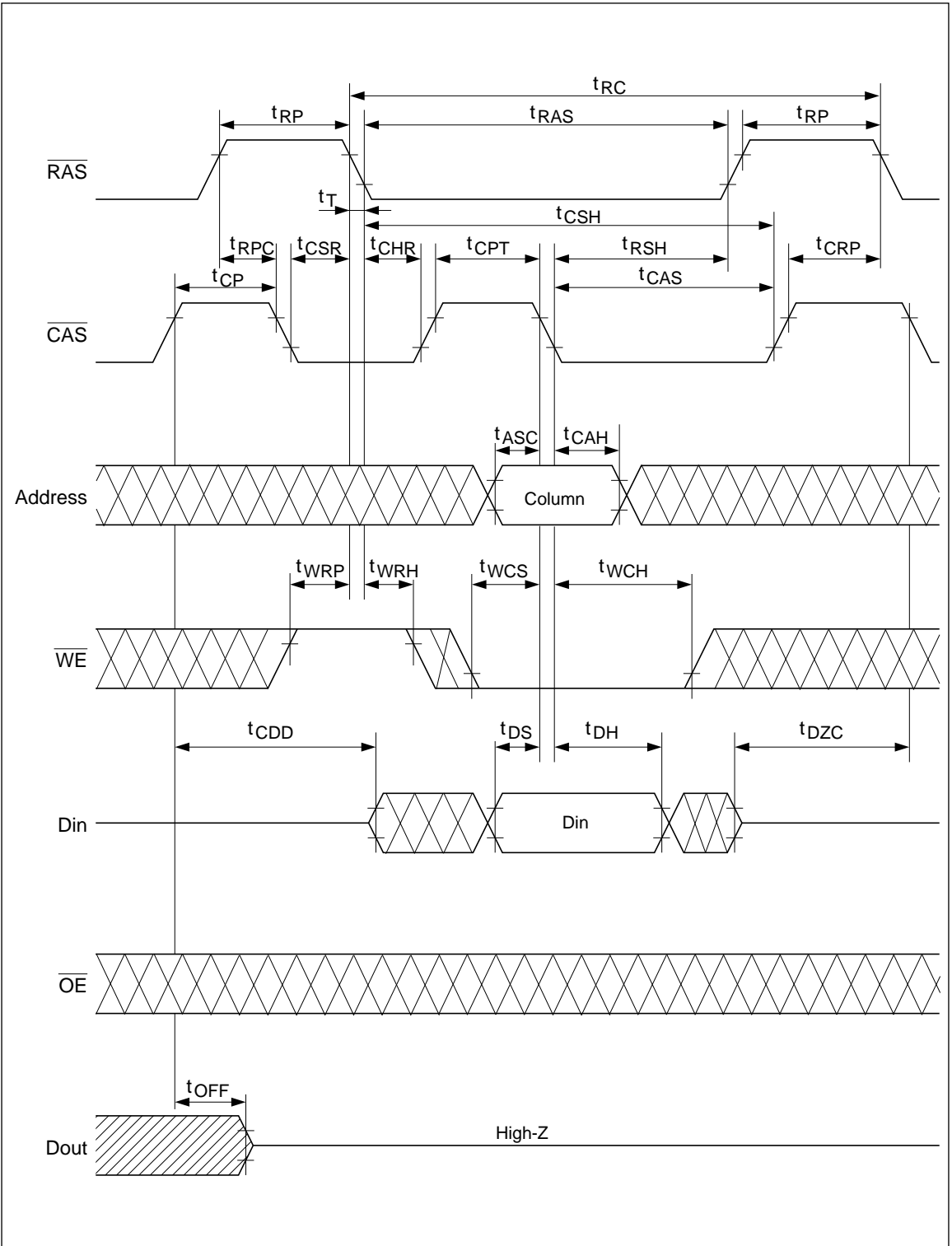


$\overline{\text{RAS}}$ -Only Refresh Cycle



HM5117400A/AL Series

$\overline{\text{CAS}}$ -Before- $\overline{\text{RAS}}$ Refresh Counter Check Cycle (Write)



HM5117400B/BL Series

Preliminary

4,194,304-word x 4-bit Dynamic Random Access Memory

HITACHI

Rev. 0.0
Mar. 23, 1995

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Ordering Information

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HM5117400BS-6	60 ns	300-mil 26-pin plastic SOJ (CP-26/24DB)
HM5117400BS-7	70 ns	
HM5117400BS-8	80 ns	
HM5117400BLS-6	60 ns	300-mil 26-pin plastic TSOP II (TTP-26/24DA)
HM5117400BLS-7	70 ns	
HM5117400BLS-8	80 ns	
HM5117400BTS-6	60 ns	300-mil 26-pin plastic TSOP II (TTP-26/24DA)
HM5117400BTS-7	70 ns	
HM5117400BTS-8	80 ns	
HM5117400BLTS-6	60 ns	300-mil 26-pin plastic TSOP II (TTP-26/24DA)
HM5117400BLTS-7	70 ns	
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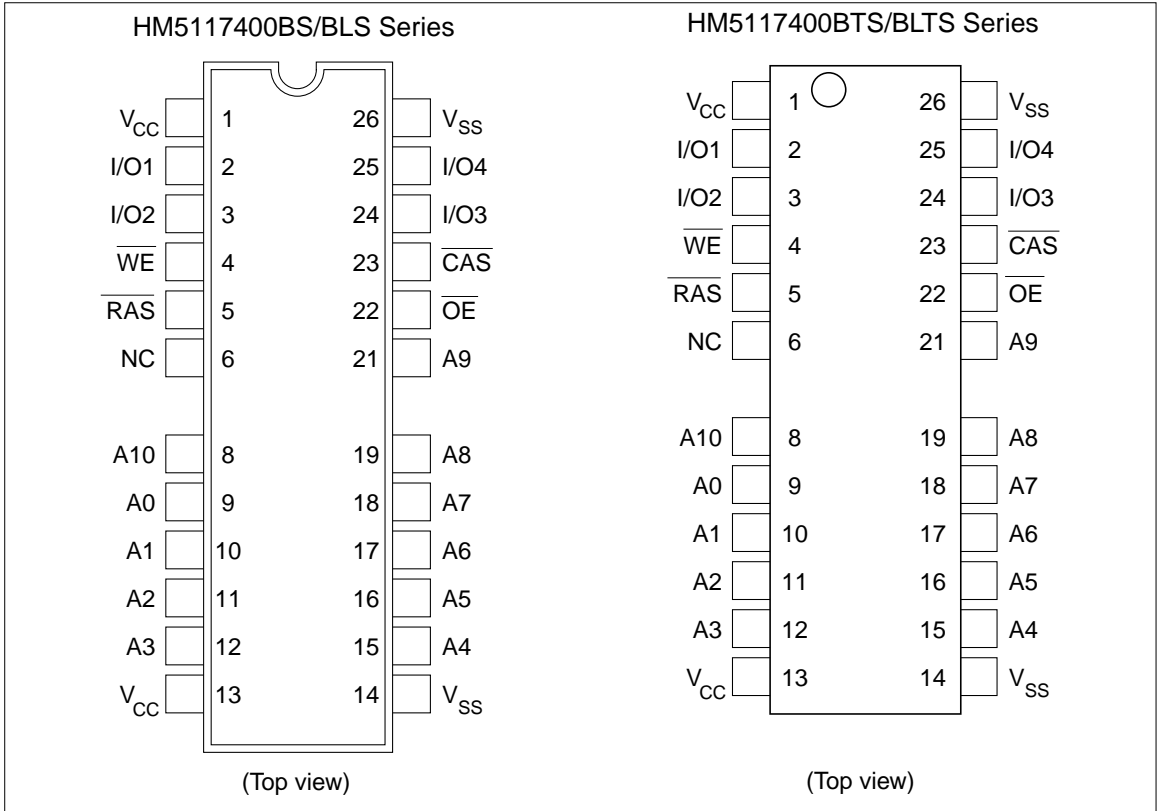
Preliminary : This document contains information on a new product. Specifications and information contained herein are subject to change without notice.

This specification is fully compatible with the 16-Mbit DRAM specifications from TEXAS INSTRUMENTS.



ADE-203-369(Z)

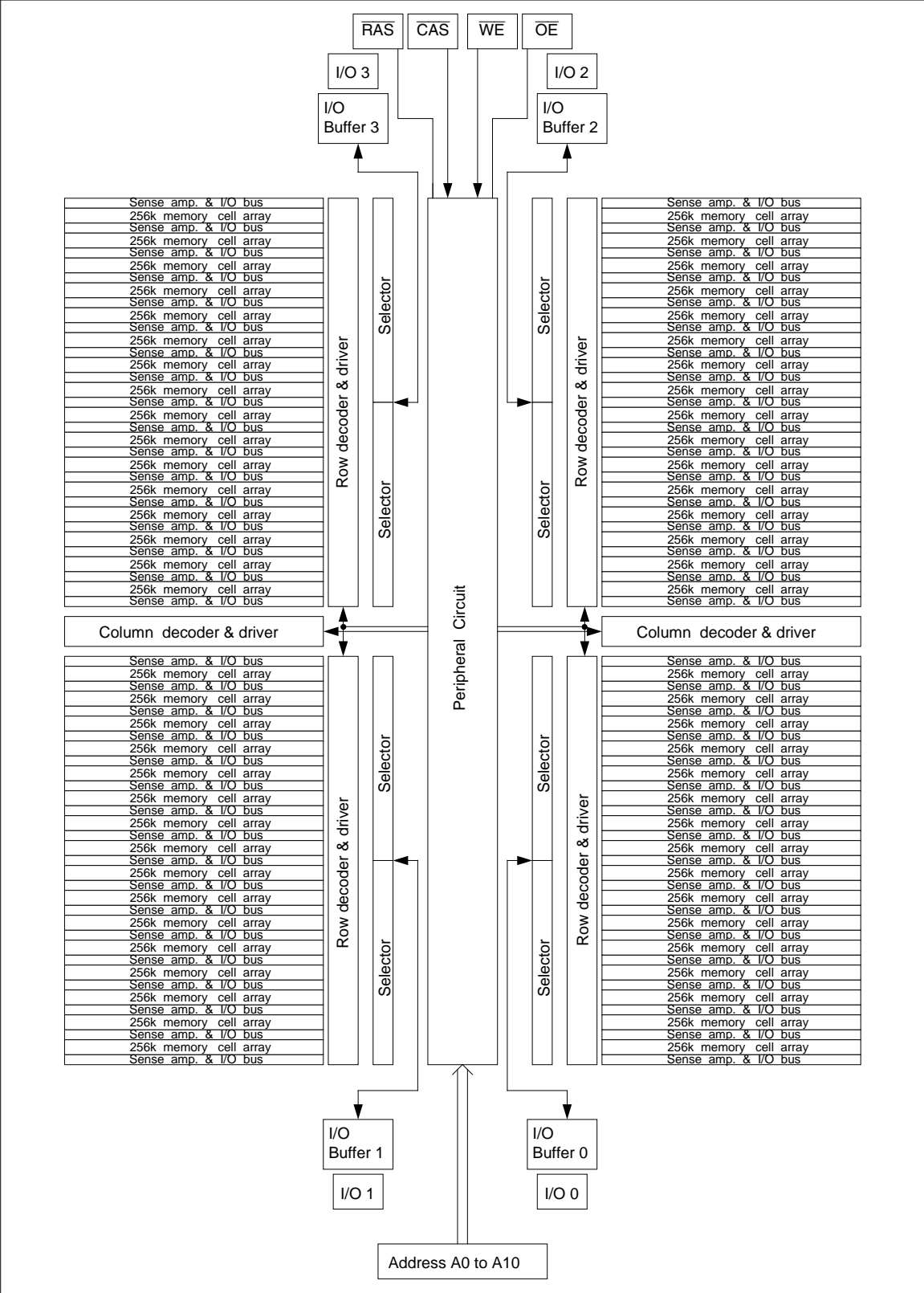
Pin Arrangement



Pin Description

Pin name	Function
A0 to A10	Address input
A0 to A10	Refresh address input
I/O0 to I/O4	Data input/data output
\overline{RAS}	Row address strobe
\overline{CAS}	Column address strobe
\overline{WE}	Write enable
\overline{OE}	Output enable
V _{CC}	Power supply (+5 V)
V _{SS}	Ground
NC	No connection

Block Diagram



Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Voltage on any pin relative to V_{SS}	V_T	-1.0 to +7.0	V
Supply voltage relative to V_{SS}	V_{CC}	-1.0 to +7.0	V
Short circuit output current	I_{out}	50	mA
Power dissipation	P_T	1.0	W
Operating temperature	T_{opr}	0 to +70	°C
Storage temperature	T_{stg}	-55 to +125	°C

Recommended DC Operating Conditions ($T_a = 0$ to $+70^\circ\text{C}$)

Parameter	Symbol	Min	Typ	Max	Unit	Note
Supply voltage	V_{CC}	4.5	5.0	5.5	V	1
Input high voltage	V_{IH}	2.4	—	6.5	V	1
Input low voltage	V_{IL}	-1.0	—	0.8	V	1

Note : 1. All voltage referred to V_{SS}

DC Characteristics (Ta = 0 to +70°C, V_{CC} = 5 V ± 10%, V_{SS} = 0 V)

		HM5117400B/BL								
		-6		-7		-8				
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Test condition	Notes
Operating current	I _{CC1}	—	110	—	100	—	90	mA	t _{RC} = min	1, 2
Standby current	I _{CC2}	—	2	—	2	—	2	mA	TTL interface RAS, CAS = V _{IH} Dout = High-Z	
		—	1	—	1	—	1	mA	CMOS interface RAS, CAS ≥ V _{CC} - 0.2V Dout = High-Z	
Standby current (L-version)		—	150	—	150	—	150	μA	CMOS interface RAS, CAS ≥ V _{CC} - 0.2V Dout = High-Z	
RAS-only refresh current	I _{CC3}	—	110	—	100	—	90	mA	t _{RC} = min	2
Standby current	I _{CC5}	—	5	—	5	—	5	mA	RAS = V _{IH} CAS = V _{IL} Dont = enable	1
CAS-before-RAS refresh current	I _{CC6}	—	110	—	100	—	90	mA	t _{RC} = min	
Fast page mode current	I _{CC7}	—	80	—	70	—	65	mA	t _{PC} = min	1,3
Battery back up current	I _{CC10}	—	350	—	350	—	350	μA	CMOS interface Dout = High-Z CBR refresh: t _{RC} = 62.5 μs t _{RAS} ≤ 0.3 μs	
Input leakage current	I _{LI}	-10	10	-10	10	-10	10	μA	0 V ≤ Vin ≤ 7 V	
Output leakage current	I _{LO}	-10	10	-10	10	-10	10	μA	0 V ≤ Vout ≤ 7 V Dout = disable	
Output high voltage	V _{OH}	2.4	V _{CC}	2.4	V _{CC}	2.4	V _{CC}	V	High Iout = -5 mA	
Output low voltage	V _{OL}	0	0.4	0	0.4	0	0.4	V	Low Iout = 4.2 mA	

- Notes : 1. I_{CC} depends on output load condition when the device is selected. I_{CC} max is specified at the output open condition.
 2. Address can be changed once or less while RAS = V_{IL}.
 3. Address can be changed once or less while CAS = V_{IH}.

Capacitance ($T_a = 25^\circ\text{C}$, $V_{CC} = 5\text{ V} \pm 10\%$)

Parameter	Symbol	Typ	Max	Unit	Notes
Input capacitance (Address)	C_{I1}	—	5	pF	1
Input capacitance (Clocks)	C_{I2}	—	7	pF	1
Output capacitance (Data-in, Data-out)	$C_{I/O}$	—	7	pF	1, 2

Notes : 1. Capacitance measured with Boonton Meter or effective capacitance measuring method.
2. $\overline{\text{CAS}} = V_{IH}$ to disable Dout.

AC Characteristics ($T_a = 0$ to $+70^\circ\text{C}$, $V_{CC} = 5\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$) *1, *2, *18, *19**Test Conditions**

Input rise and fall times : 5 ns

Input timing reference levels : 0.8 V, 2.4 V

Output load : 2 TTL gate + C_L (100 pF)
(Including scope and jig)

Read, Write, Read-Modify-Write and Refresh Cycles (Common parameters)

		HM5117400B/BL							
		-6		-7		-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Random read or write cycle time	t_{RC}	110	—	130	—	150	—	ns	
\overline{RAS} precharge time	t_{RP}	40	—	50	—	60	—	ns	
\overline{CAS} precharge time	t_{CP}	10	—	10	—	10	—	ns	
\overline{RAS} pulse width	t_{RAS}	60	10000	70	10000	80	10000	ns	
\overline{CAS} pulse width	t_{CAS}	15	10000	18	10000	20	10000	ns	
Row address setup time	t_{ASR}	0	—	0	—	0	—	ns	
Row address hold time	t_{RAH}	10	—	10	—	10	—	ns	
Column address setup time	t_{ASC}	0	—	0	—	0	—	ns	
Column address hold time	t_{CAH}	10	—	15	—	15	—	ns	
\overline{RAS} to \overline{CAS} delay time	t_{RCD}	20	45	20	52	20	60	ns	3
\overline{RAS} to column address delay time	t_{RAD}	15	30	15	35	15	40	ns	4
\overline{RAS} hold time	t_{RSH}	15	—	18	—	20	—	ns	
\overline{CAS} hold time	t_{CSH}	60	—	70	—	80	—	ns	
\overline{CAS} to \overline{RAS} precharge time	t_{CRP}	5	—	5	—	5	—	ns	
\overline{OE} to Din delay time	t_{OED}	15	—	18	—	20	—	ns	5
\overline{OE} delay time from Din	t_{DZO}	0	—	0	—	0	—	ns	6
\overline{CAS} delay time from Din	t_{DZC}	0	—	0	—	0	—	ns	6
Transition time (rise and fall)	t_T	3	50	3	50	3	50	ns	7

Read Cycle

		HM5117400B/BL							
		-6		-7		-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Access time from $\overline{\text{RAS}}$	t_{RAC}	—	60	—	70	—	80	ns	8, 9, 20
Access time from $\overline{\text{CAS}}$	t_{CAC}	—	15	—	18	—	20	ns	9, 10, 17, 20
Access time from address	t_{AA}	—	30	—	35	—	40	ns	9, 11, 17, 20
Access time from $\overline{\text{OE}}$	t_{OEA}	—	15	—	18	—	20	ns	9, 20
Read command setup time	t_{RCS}	0	—	0	—	0	—	ns	
Read command hold time to $\overline{\text{CAS}}$	t_{RCH}	0	—	0	—	0	—	ns	12
Read command hold time to $\overline{\text{RAS}}$	t_{RRH}	0	—	0	—	0	—	ns	12
Column address to $\overline{\text{RAS}}$ lead time	t_{RAL}	30	—	35	—	40	—	ns	
Column address to $\overline{\text{CAS}}$ lead time	t_{CAL}	30	—	35	—	40	—	ns	
$\overline{\text{CAS}}$ to output in low-Z	t_{CLZ}	0	—	0	—	0	—	ns	
Output data hold time	t_{OH}	3	—	3	—	3	—	ns	
Output data hold time from $\overline{\text{OE}}$	t_{OHO}	3	—	3	—	3	—	ns	
Output buffer turn-off time	t_{OFF}	—	15	—	15	—	15	ns	13
Output buffer turn-off to $\overline{\text{OE}}$	t_{OEZ}	—	15	—	15	—	15	ns	13
$\overline{\text{CAS}}$ to Din delay time	t_{CDD}	15	—	18	—	20	—	ns	5

Write Cycle

		HM5117400B/BL							
		-6		-7		-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Write command setup time	t_{WCS}	0	—	0	—	0	—	ns	14
Write command hold time	t_{WCH}	10	—	15	—	15	—	ns	
Write command pulse width	t_{WP}	10	—	10	—	10	—	ns	
Write command to \overline{RAS} lead time	t_{RWL}	15	—	18	—	20	—	ns	
Write command to \overline{CAS} lead time	t_{CWL}	15	—	18	—	20	—	ns	
Data-in setup time	t_{DS}	0	—	0	—	0	—	ns	15
Data-in hold time	t_{DH}	10	—	15	—	15	—	ns	15

Read-Modify-Write Cycle

		HM5117400B/BL							
		-6		-7		-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Read-modify-write cycle time	t_{RWC}	155	—	181	—	205	—	ns	
\overline{RAS} to \overline{WE} delay time	t_{RWD}	85	—	98	—	110	—	ns	14
\overline{CAS} to \overline{WE} delay time	t_{CWD}	40	—	46	—	50	—	ns	14
Column address to \overline{WE} delay time	t_{AWD}	55	—	63	—	70	—	ns	14
\overline{OE} hold time from \overline{WE}	t_{OEHL}	15	—	18	—	20	—	ns	

Refresh Cycle

		HM5117400B/BL							
		-6		-7		-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
$\overline{\text{CAS}}$ setup time (CBR refresh cycle)	t _{CSR}	5	—	5	—	5	—	ns	
$\overline{\text{CAS}}$ hold time (CBR refresh cycle)	t _{CHR}	10	—	10	—	10	—	ns	
$\overline{\text{WE}}$ setup time (CBR refresh cycle)	t _{WRP}	0	—	0	—	0	—	ns	
$\overline{\text{WE}}$ hold time (CBR refresh cycle)	t _{WRH}	10	—	10	—	10	—	ns	
$\overline{\text{RAS}}$ precharge to $\overline{\text{CAS}}$ hold time	t _{RPC}	0	—	0	—	0	—	ns	

Fast Page Mode Cycle

		HM5117400B/BL							
		-6		-7		-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Fast page mode cycle time	t _{PC}	40	—	45	—	50	—	ns	
Fast page mode $\overline{\text{RAS}}$ pulse width	t _{RASP}	—	100000	—	100000	—	100000	ns	16
Access time from $\overline{\text{CAS}}$ precharge	t _{CPA}	—	35	—	40	—	45	ns	9, 17, 20
$\overline{\text{RAS}}$ hold time from $\overline{\text{CAS}}$ precharge	t _{CPRH}	35	—	40	—	45	—	ns	

Fast Page Mode Read-Modify-Write Cycle

		HM5117400B/BL							
		-6		-7		-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Note
Fast page mode read-modify-write cycle time	t _{PRWC}	85	—	96	—	105	—	ns	
$\overline{\text{WE}}$ delay time from $\overline{\text{CAS}}$ precharge	t _{CPW}	60	—	68	—	75	—	ns	14

Test Mode Cycle *20

		HM5117400B/BL							
		-6		-7		-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Note
Test mode \overline{WE} setup time	t_{WTS}	0	—	0	—	0	—	ns	
Test mode \overline{WE} hold time	t_{WTH}	10	—	10	—	10	—	ns	

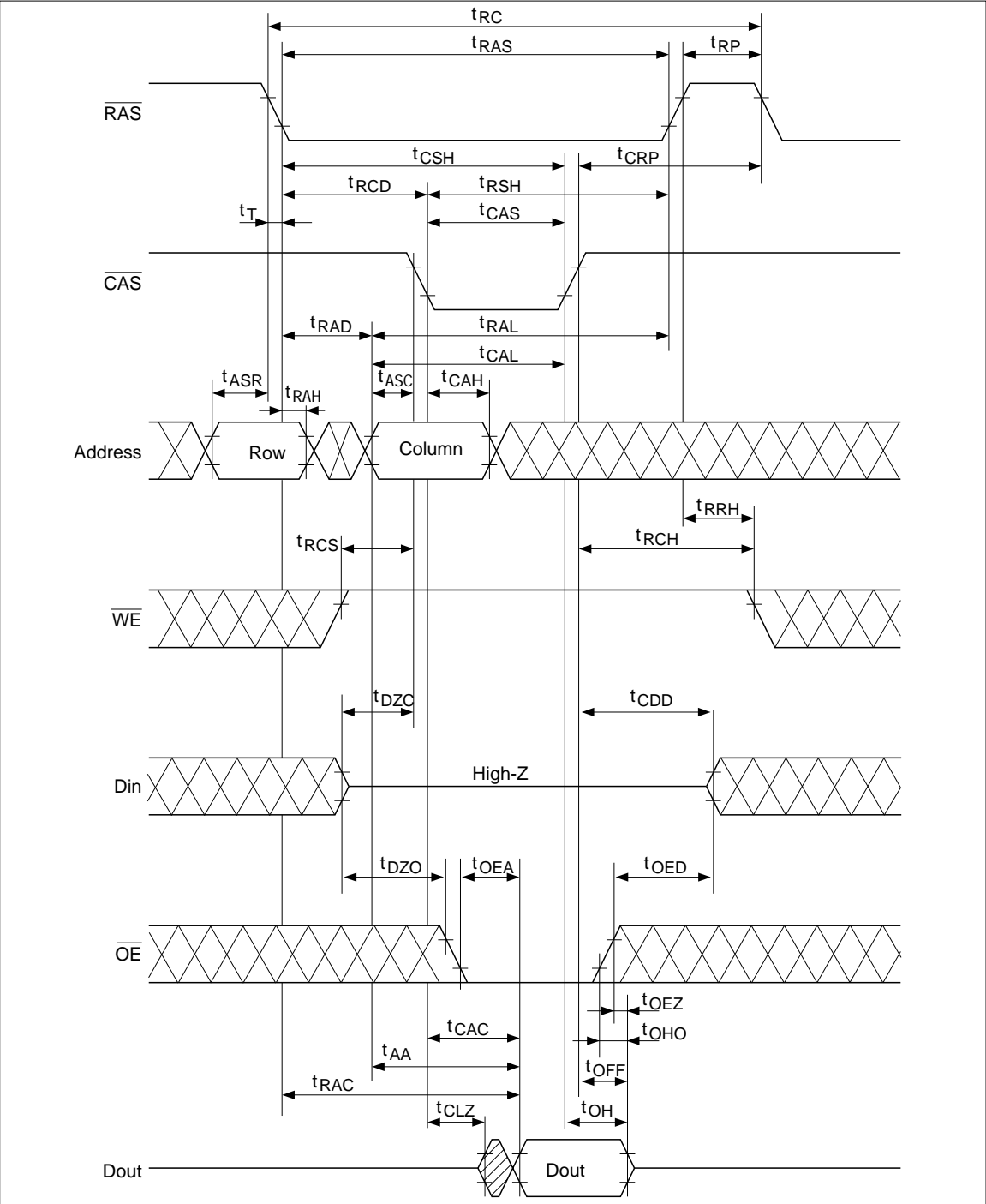
Refresh

Parameter	Symbol	Max	Unit	Note
Refresh period	t_{REF}	32	ms	2048 cycles
Refresh period (L-version)	t_{REF}	128	ms	2048 cycles

- Notes:
1. AC measurements assume $t_T = 5$ ns.
 2. An initial pause of 200 μ s is required after power up followed by a minimum of eight initialization cycles (any combination of cycles containing $\overline{\text{RAS}}$ -only refresh or $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh). If the internal refresh counter is used, a minimum of eight $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh cycles are required.
 3. Operation with the t_{RCD} (max) limit insures that t_{RAC} (max) can be met, t_{RCD} (max) is specified as a reference point only; if t_{RCD} is greater than the specified t_{RCD} (max) limit, then access time is controlled exclusively by t_{CAC} .
 4. Operation with the t_{RAD} (max) limit insures that t_{RAC} (max) can be met, t_{RAD} (max) is specified as a reference point only; if t_{RAD} is greater than the specified t_{RAD} (max) limit, then access time is controlled exclusively by t_{AA} .
 5. Either t_{OED} or t_{CDD} must be satisfied.
 6. Either t_{DZO} or t_{DZC} must be satisfied.
 7. V_{IH} (min) and V_{IL} (max) are reference levels for measuring timing of input signals. Also, transition times are measured between V_{IH} (min) and V_{IL} (max).
 8. Assumes that $t_{\text{RCD}} \leq t_{\text{RCD}}$ (max) and $t_{\text{RAD}} \leq t_{\text{RAD}}$ (max). If t_{RCD} or t_{RAD} is greater than the maximum recommended value shown in this table, t_{RAC} exceeds the value shown.
 9. Measured with a load circuit equivalent to 2 TTL loads and 100 pF.
 10. Assumes that $t_{\text{RCD}} \geq t_{\text{RCD}}$ (max) and $t_{\text{RAD}} \leq t_{\text{RAD}}$ (max).
 11. Assumes that $t_{\text{RCD}} \leq t_{\text{RCD}}$ (max) and $t_{\text{RAD}} \geq t_{\text{RAD}}$ (max).
 12. Either t_{RCH} or t_{RRH} must be satisfied for a read cycles.
 13. t_{OFF} (max) and t_{OEZ} (max) define the time at which the outputs achieve the open circuit condition and are not referred to output voltage levels.
 14. t_{WCS} , t_{RWD} , t_{CWD} , t_{AWD} and t_{CPW} are not restrictive operating parameters. They are included in the data sheet as electrical characteristics only; if $t_{\text{WCS}} \geq t_{\text{WCS}}$ (min), the cycle is an early write cycle and the data out pin will remain open circuit (high impedance) throughout the entire cycle; if $t_{\text{RWD}} \geq t_{\text{RWD}}$ (min), $t_{\text{CWD}} \geq t_{\text{CWD}}$ (min), and $t_{\text{AWD}} \geq t_{\text{AWD}}$ (min), or $t_{\text{CWD}} \geq t_{\text{CWD}}$ (min), $t_{\text{AWD}} \geq t_{\text{AWD}}$ (min) and $t_{\text{CPW}} \geq t_{\text{CPW}}$ (min), the cycle is a read-modify-write and the data output will contain data read from the selected cell; if neither of the above sets of conditions is satisfied, the condition of the data out (at access time) is indeterminate.
 15. These parameters are referred to $\overline{\text{CAS}}$ leading edge in early write cycles and to $\overline{\text{WE}}$ leading edge in delayed write or read-modify-write cycles.
 16. t_{RASP} defines $\overline{\text{RAS}}$ pulse width in fast page mode cycles.
 17. Access time is determined by the longer of t_{AA} or t_{CAC} or t_{CPA} .
 18. In delayed write or read-modify-write cycles, $\overline{\text{OE}}$ must disable output buffer prior to applying data to the device. After $\overline{\text{RAS}}$ is reset, if $t_{\text{OEH}} \geq t_{\text{CWL}}$, the I/O pin will remain open circuit (high impedance); if $t_{\text{OEH}} \leq t_{\text{CWL}}$, invalid data will be out at each I/O.
 19. The 16M DRAM offers a 16-bits time saving parallel test mode. Address CA0 and CA1 for the 4M x 4 are don't care during test mode. Test mode is set by performing $\overline{\text{WE}}$ -and- $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ (WCBR) cycle. In 16-bits parallel test mode, data is written into 4 bits in parallel at each I/O (I/O1 to I/O4) and read out from each I/O.
If 4 bits of each I/O are equal (all 1s or 0s), data output pin is a high state during test mode read cycle, then the device has passed. If they are not equal, data output pin is a low state, then the device has failed.
Refresh during test mode operation can be performed by normal read cycles or by WCBR refresh cycles.
To get out of test mode and enter a normal operation mode, perform either a regular $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh cycle or $\overline{\text{RAS}}$ -only refresh cycle.
 20. In a test mode read cycle, the value of t_{RAC} , t_{AA} , t_{CAC} and t_{CPA} is delayed by 2 ns to 5 ns for the specified value. These parameters should be specified in test mode cycles by adding the above value to the specified value in this data sheet.

Timing Waveforms*21

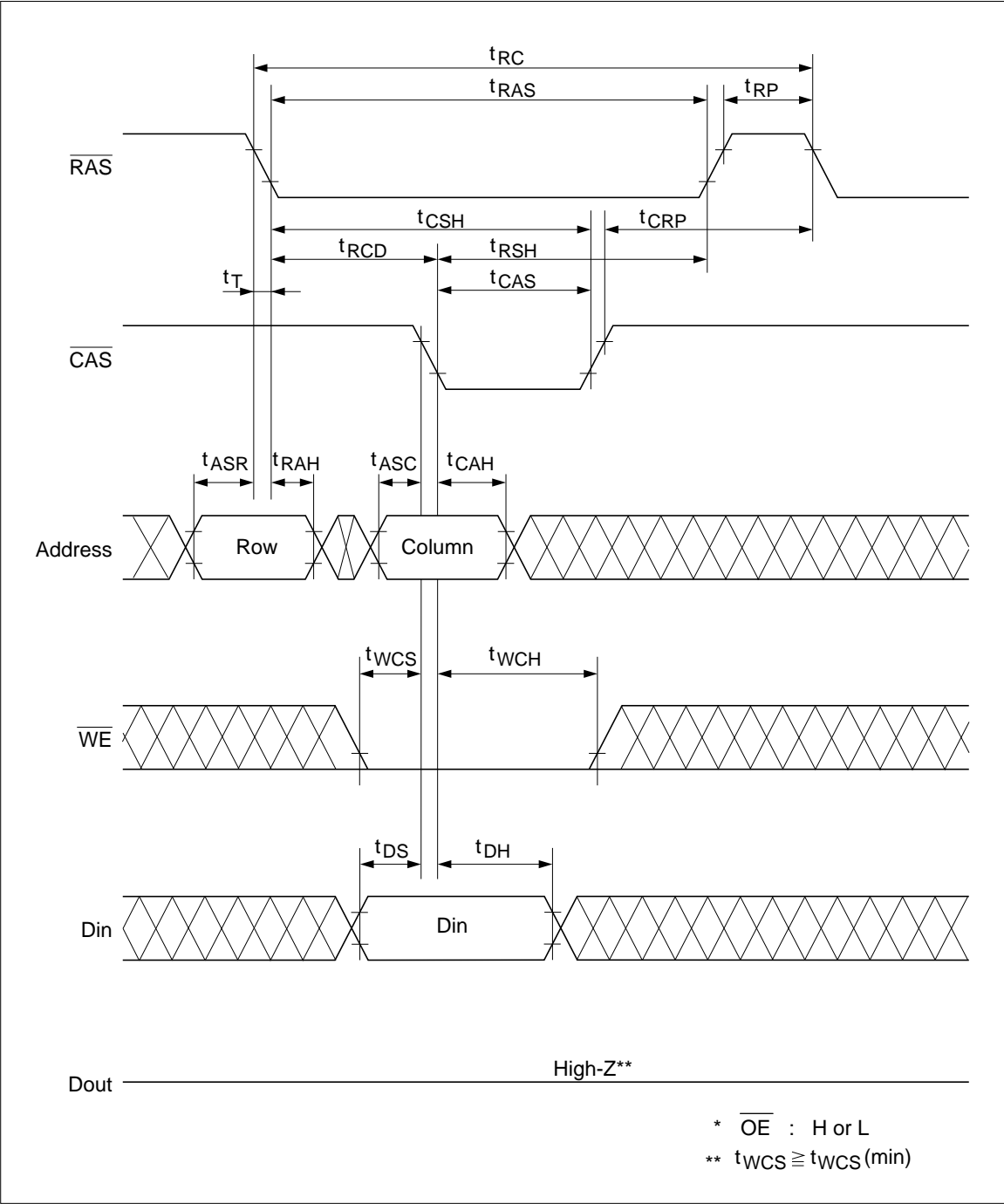
Read Cycle



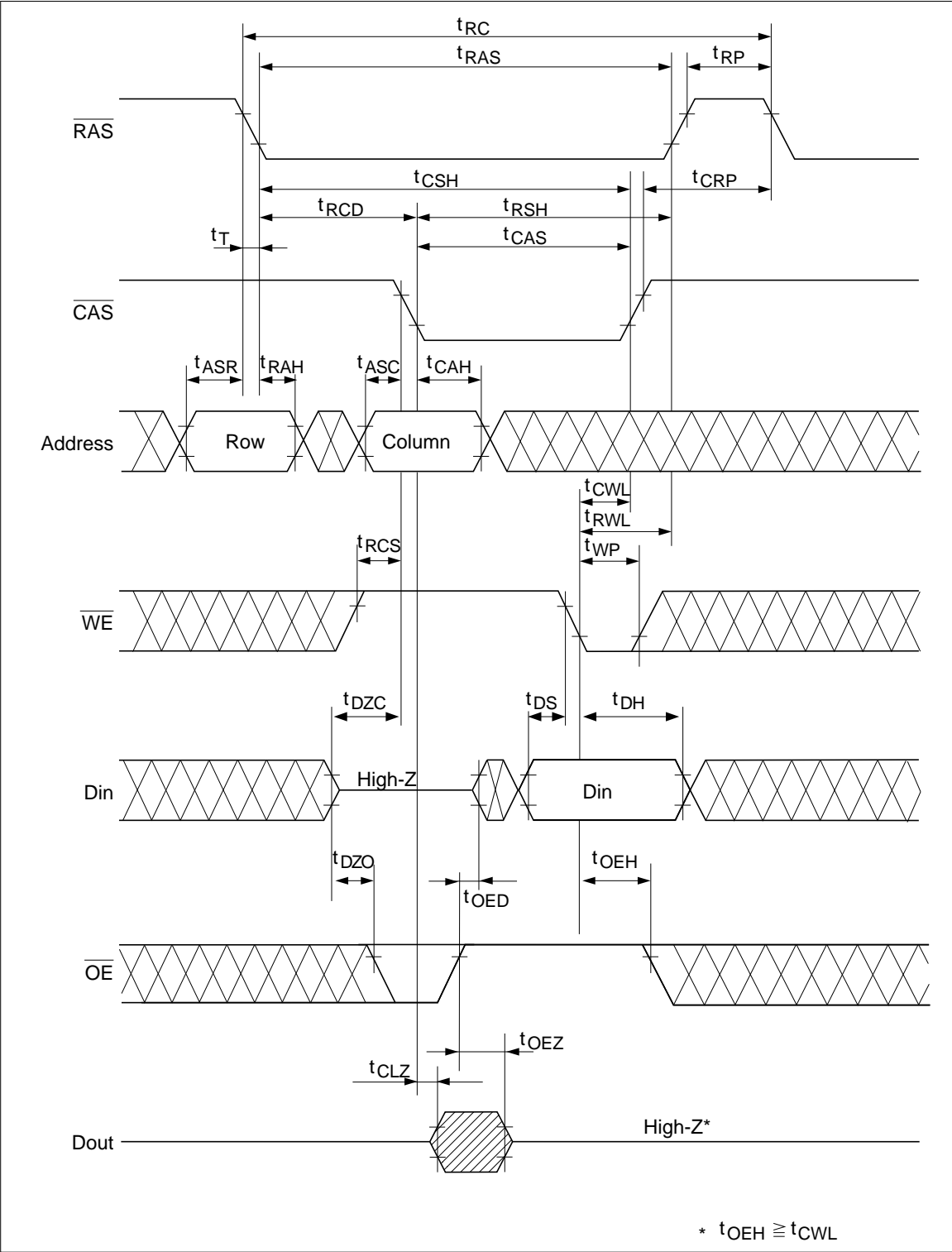
Note: 21

- H or L (H: $V_{\text{IH}}(\text{min}) \leq V_{\text{IN}} \leq V_{\text{IH}}(\text{max})$, L: $V_{\text{IL}}(\text{min}) \leq V_{\text{IN}} \leq V_{\text{IL}}(\text{max})$)
- Invalid Dout

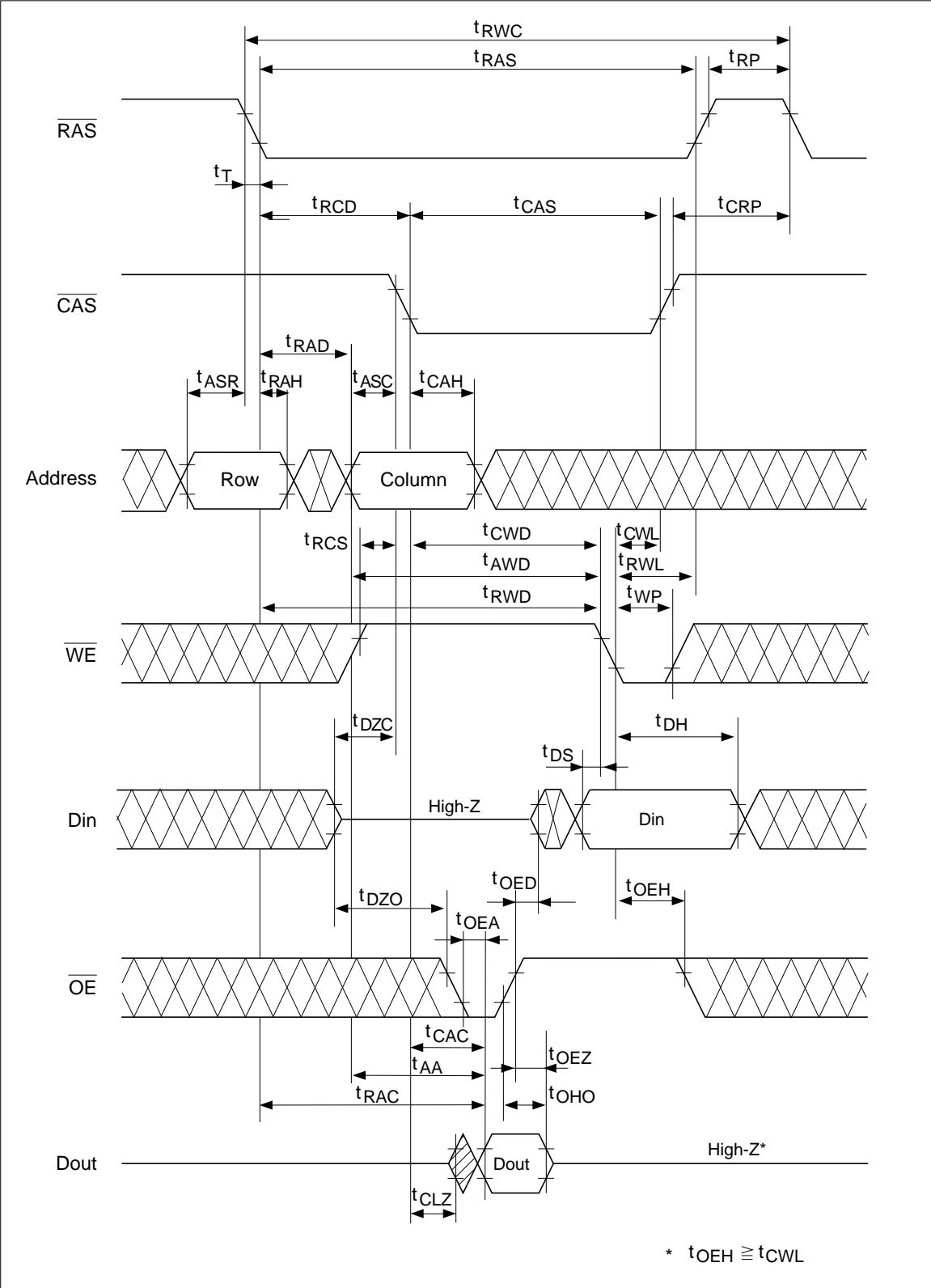
Early Write Cycle



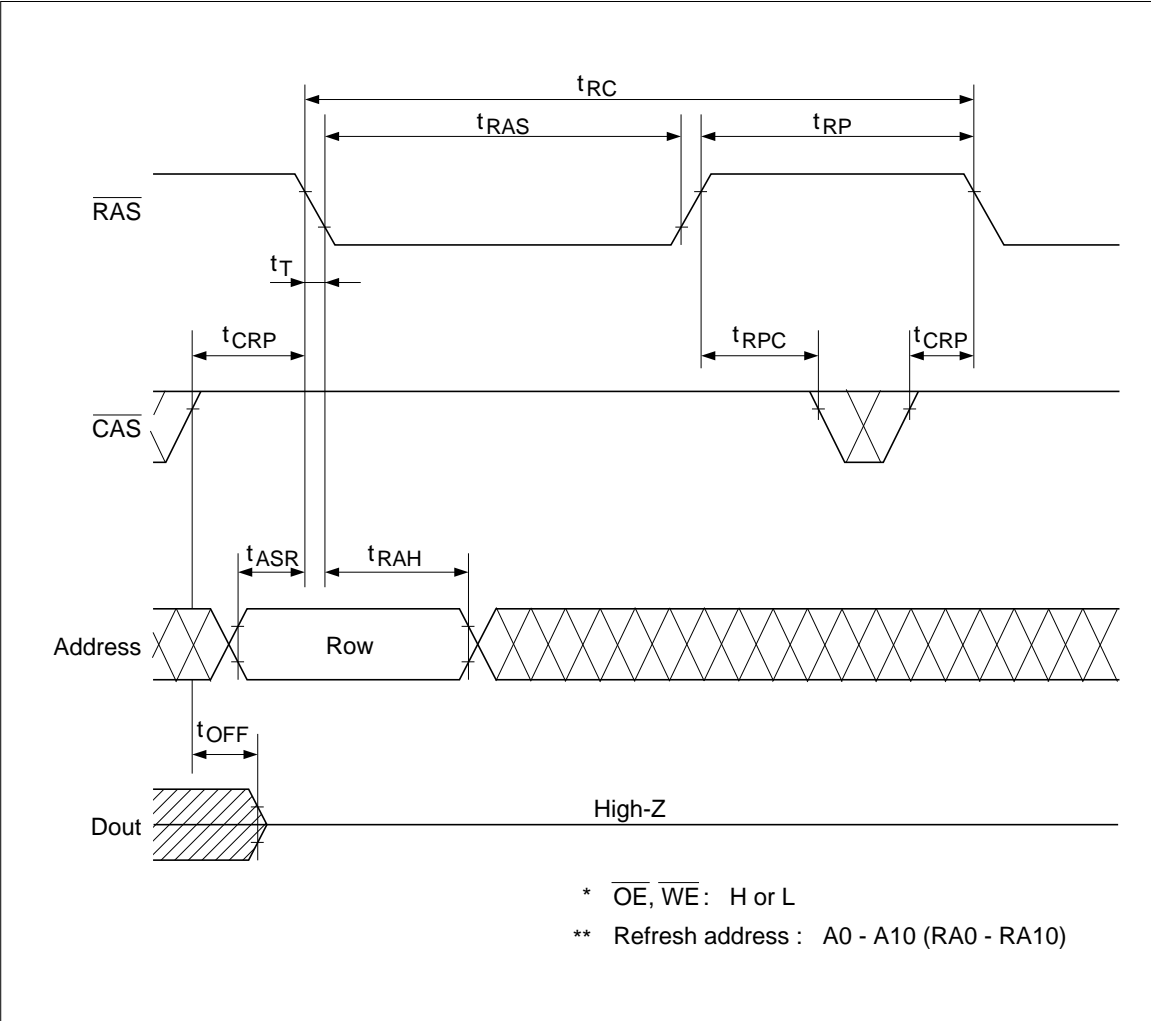
Delayed Write Cycle *18



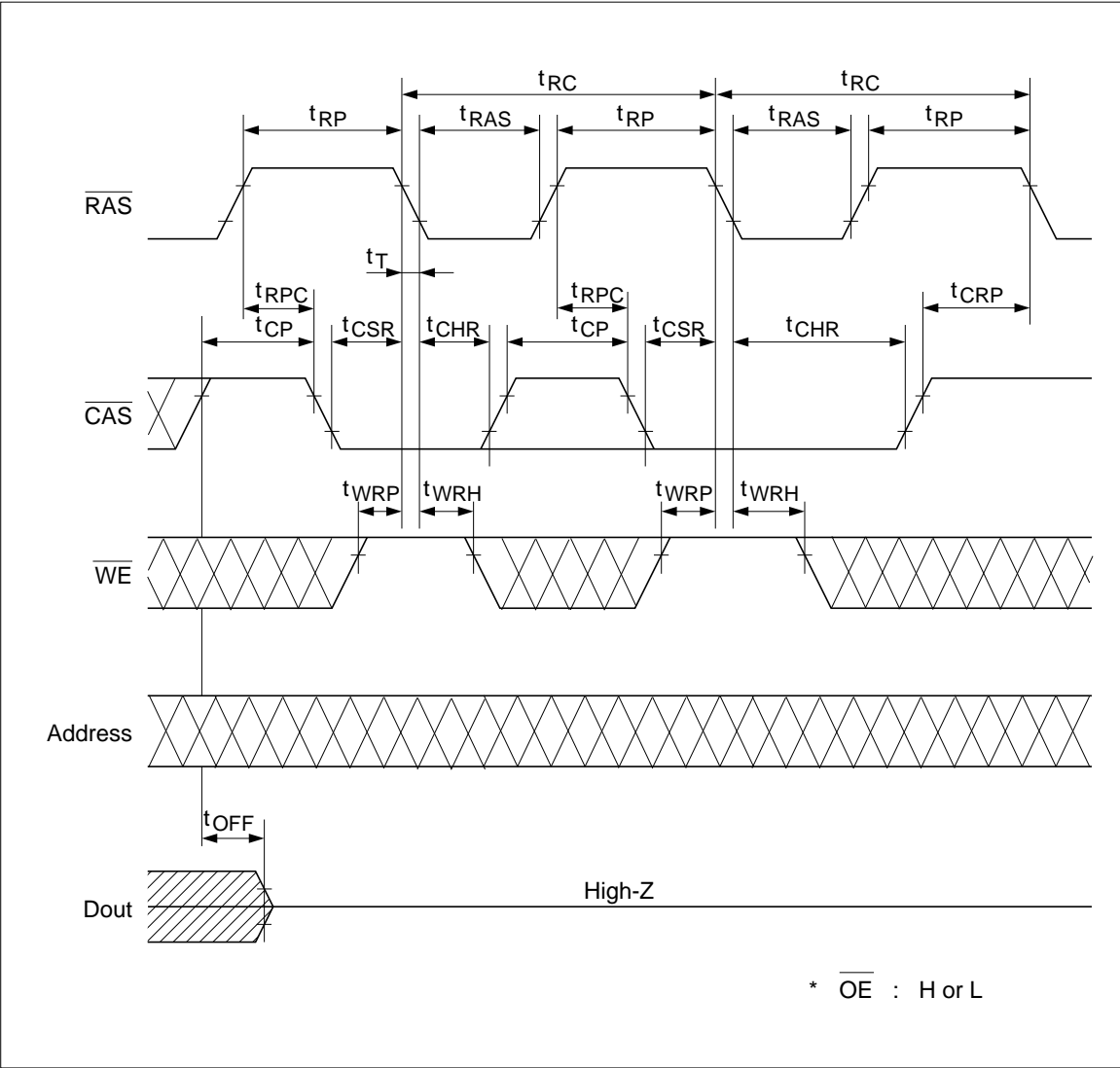
Read-Modify-Write Cycle *18



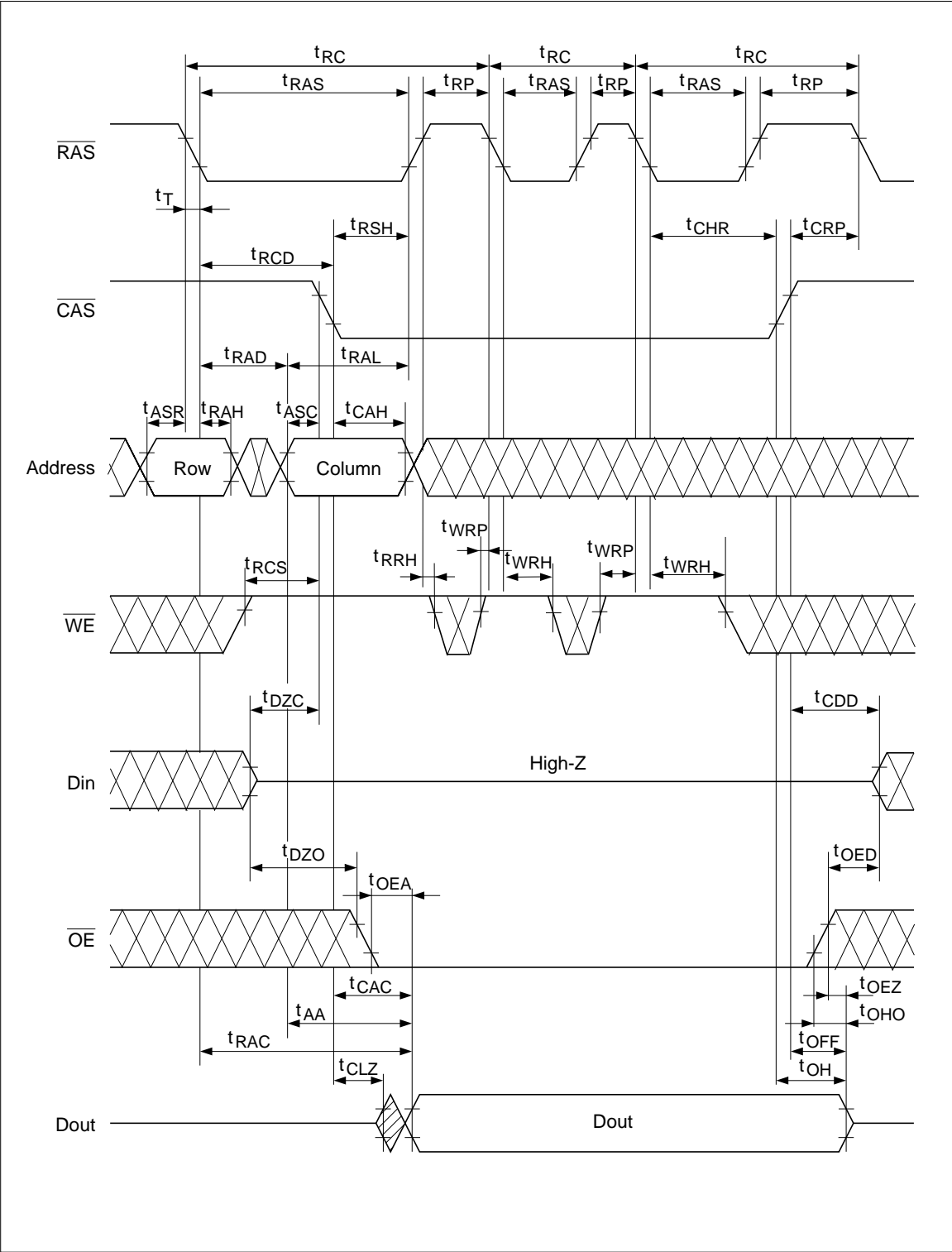
RAS-Only Refresh Cycle



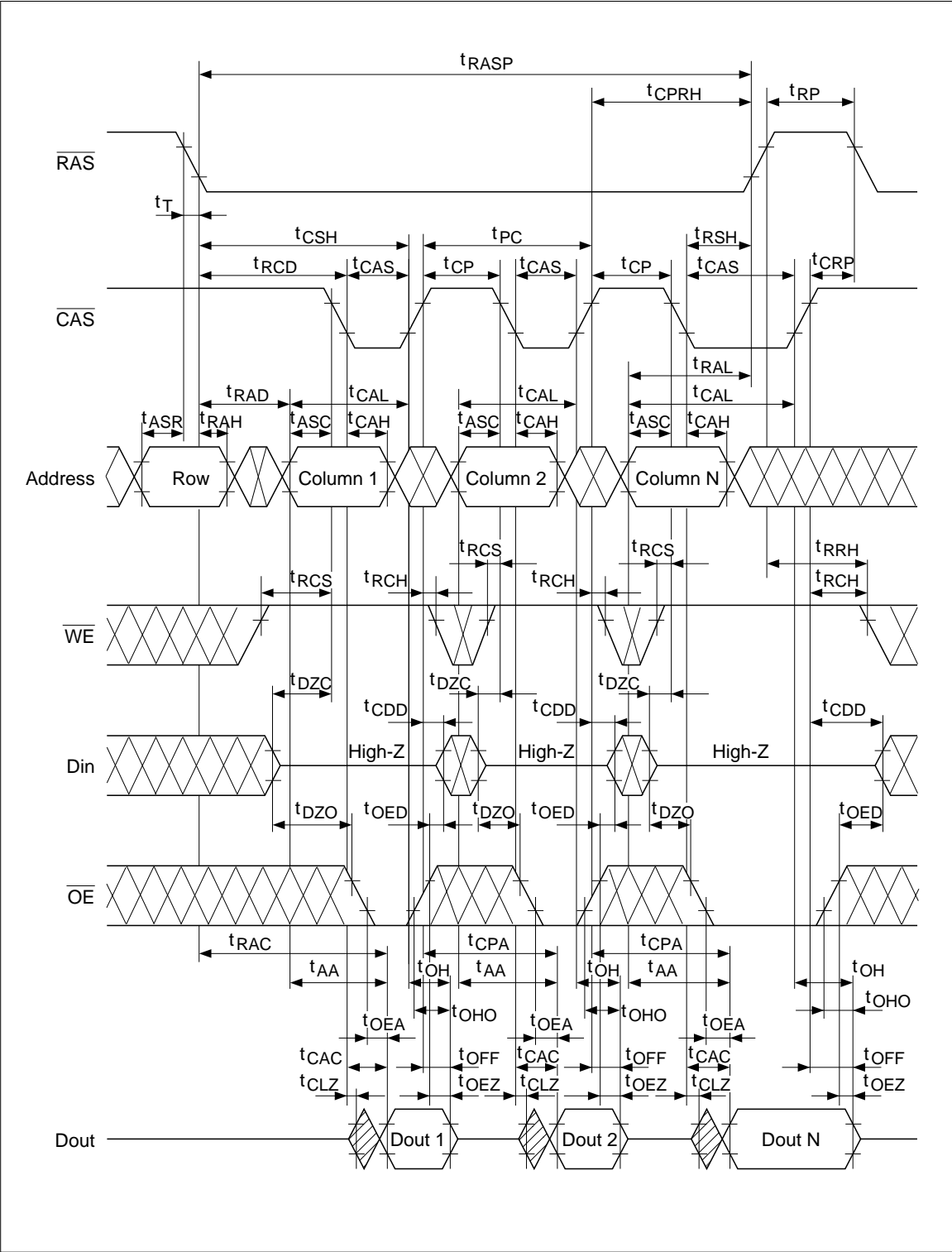
CAS-Before-RAS Refresh Cycle



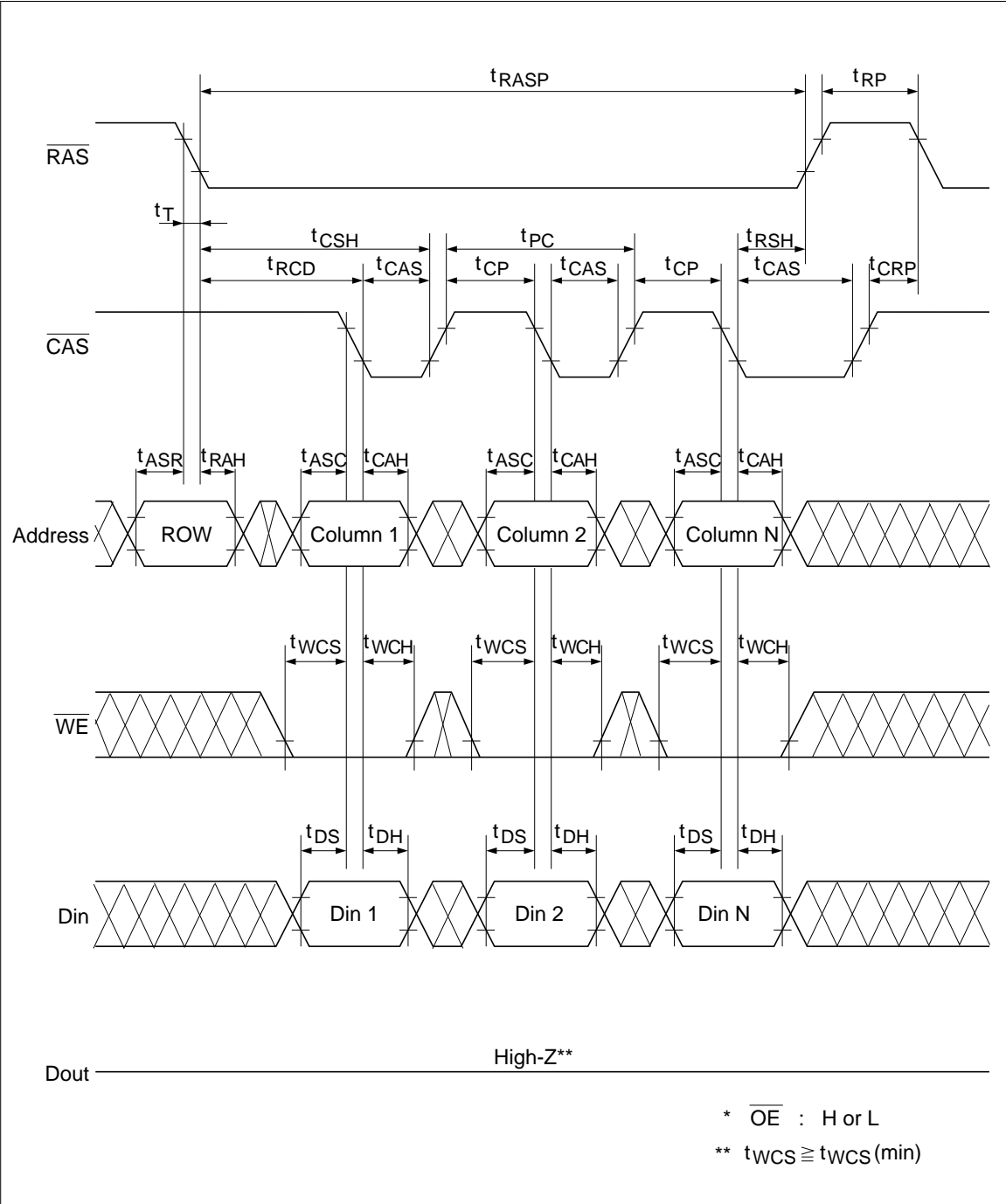
Hidden Refresh Cycle



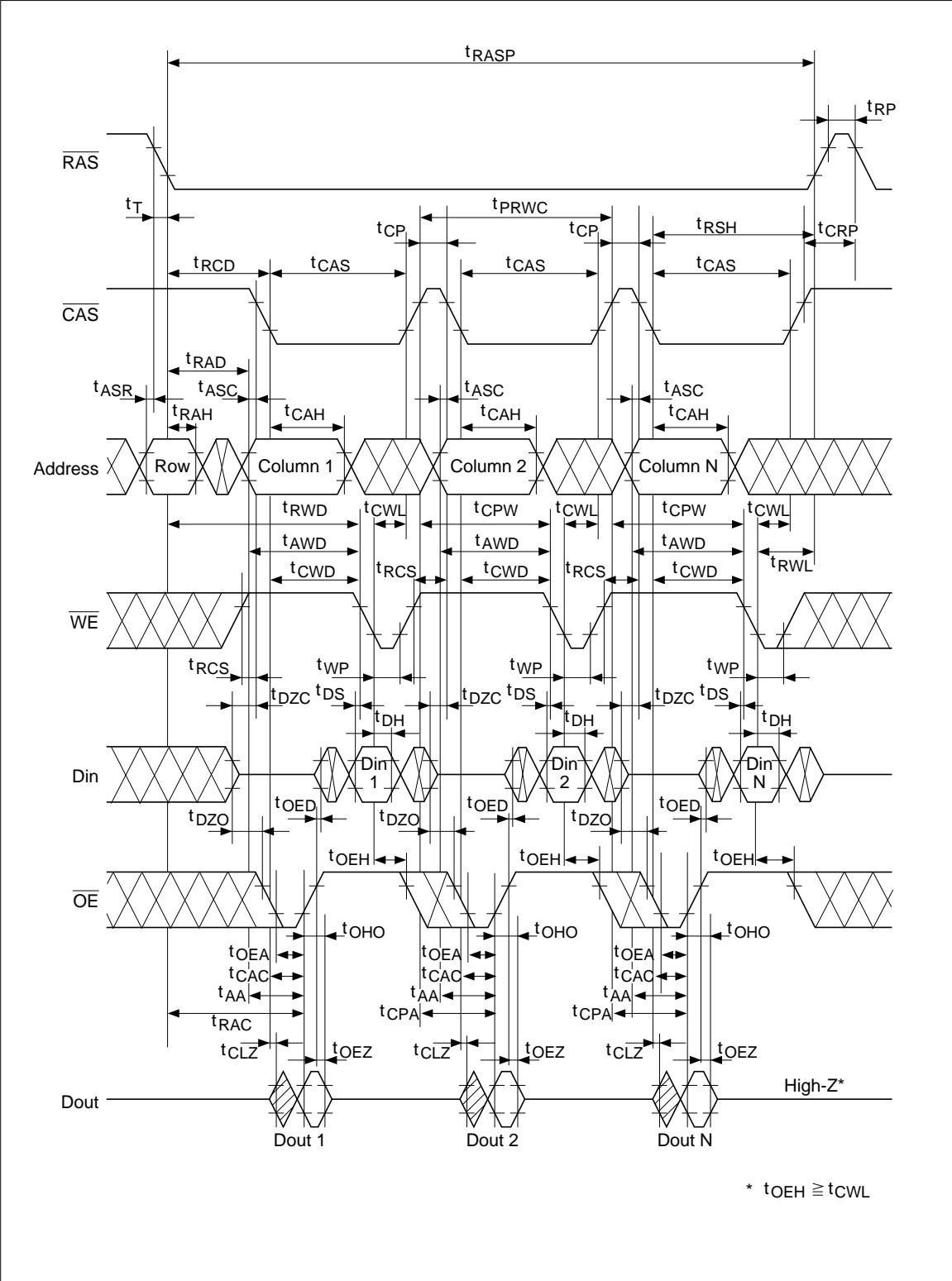
Fast Page Mode Read Cycle



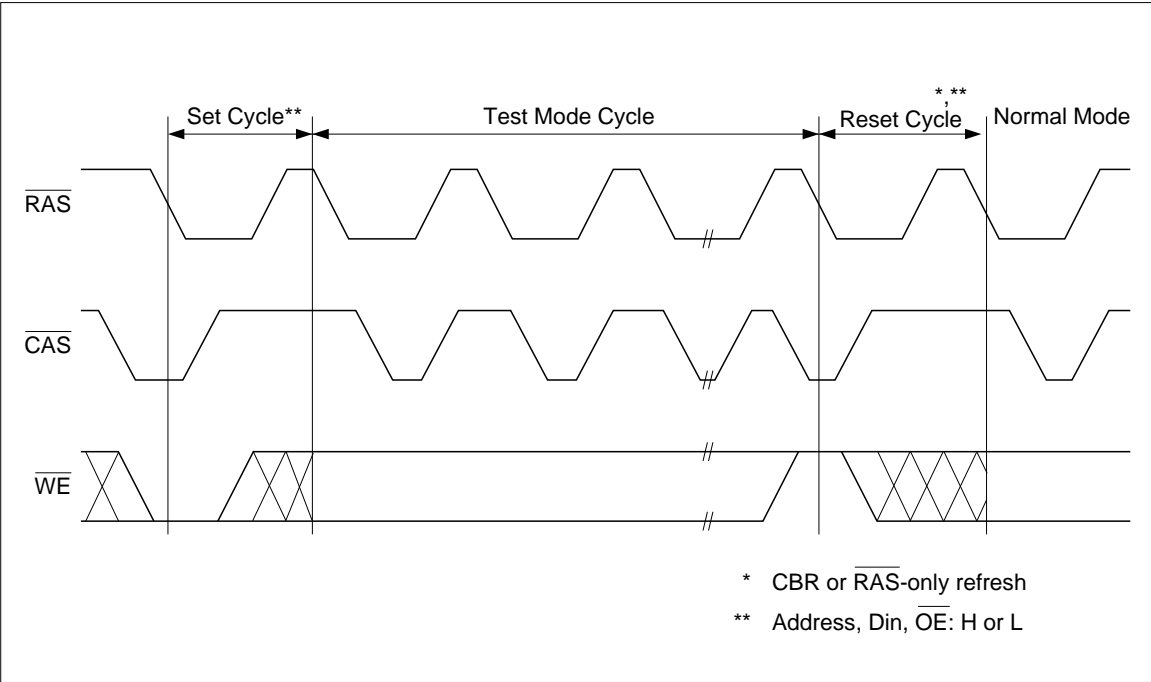
Fast Page Mode Early Write Cycle



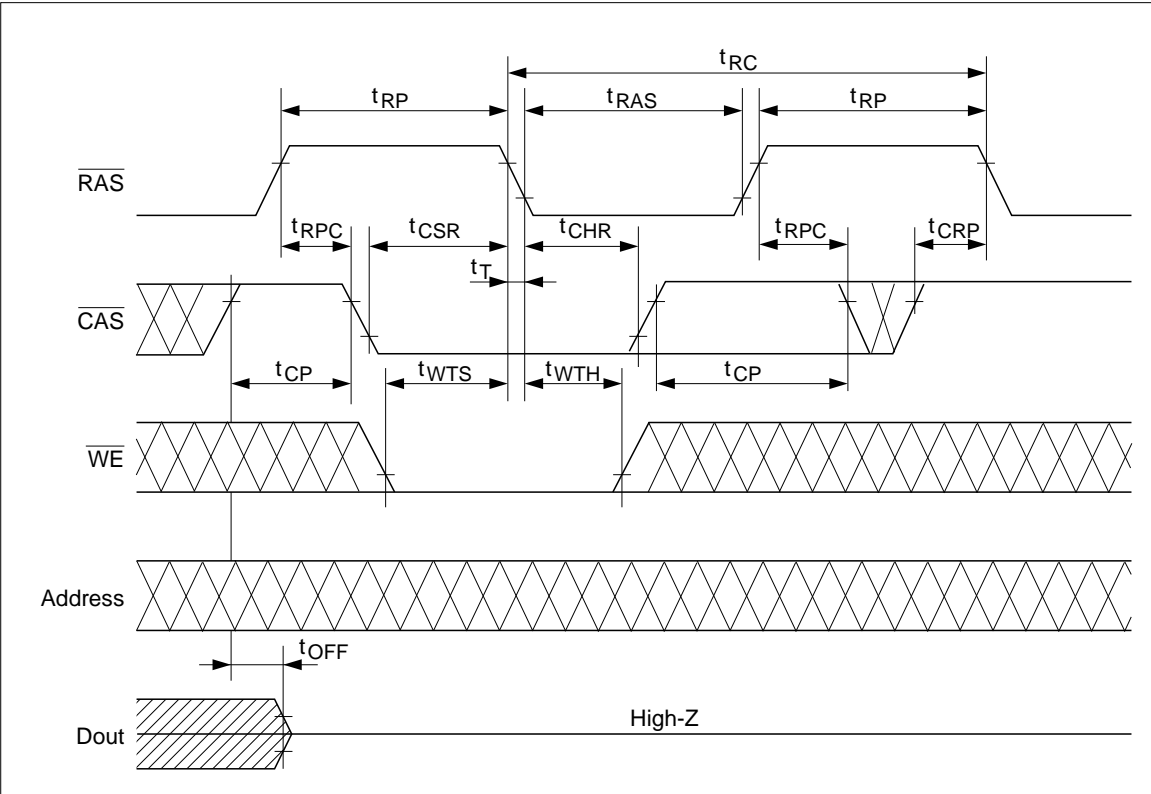
Fast Page Mode Read-Modify-Write Cycle *18



Test Mode Cycle *19

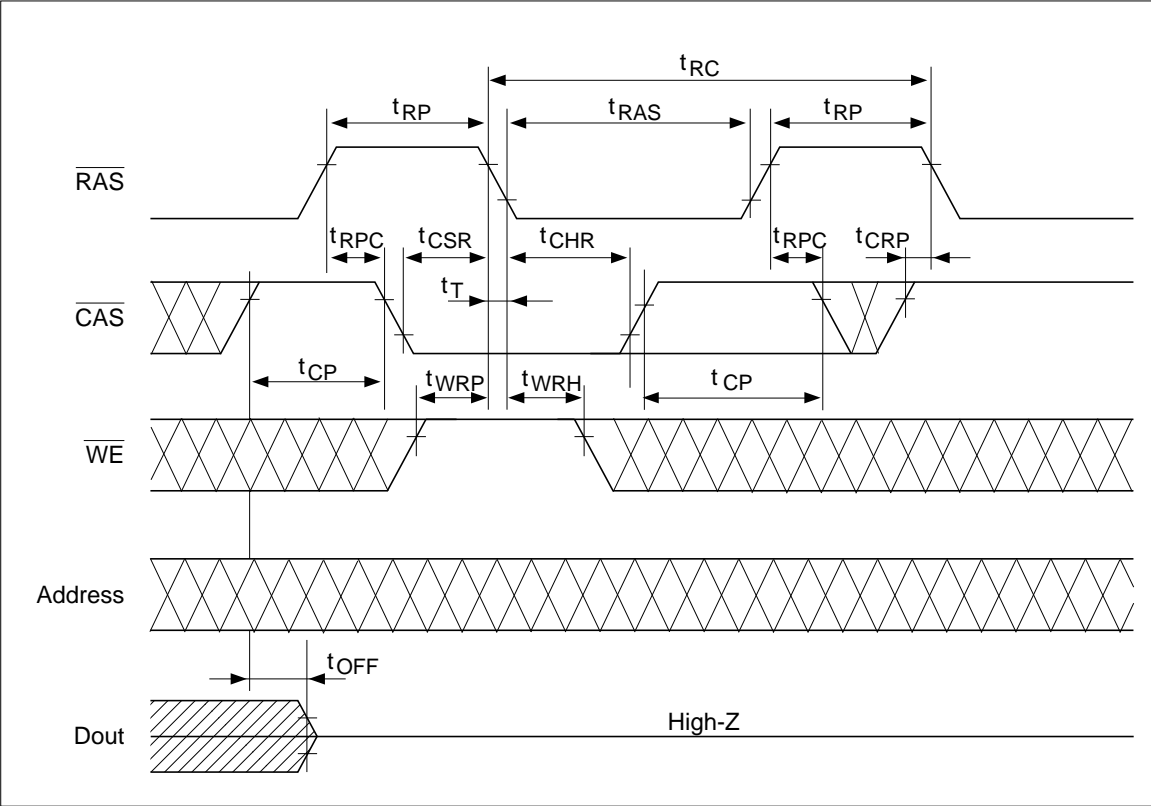


Test Mode Set Cycle

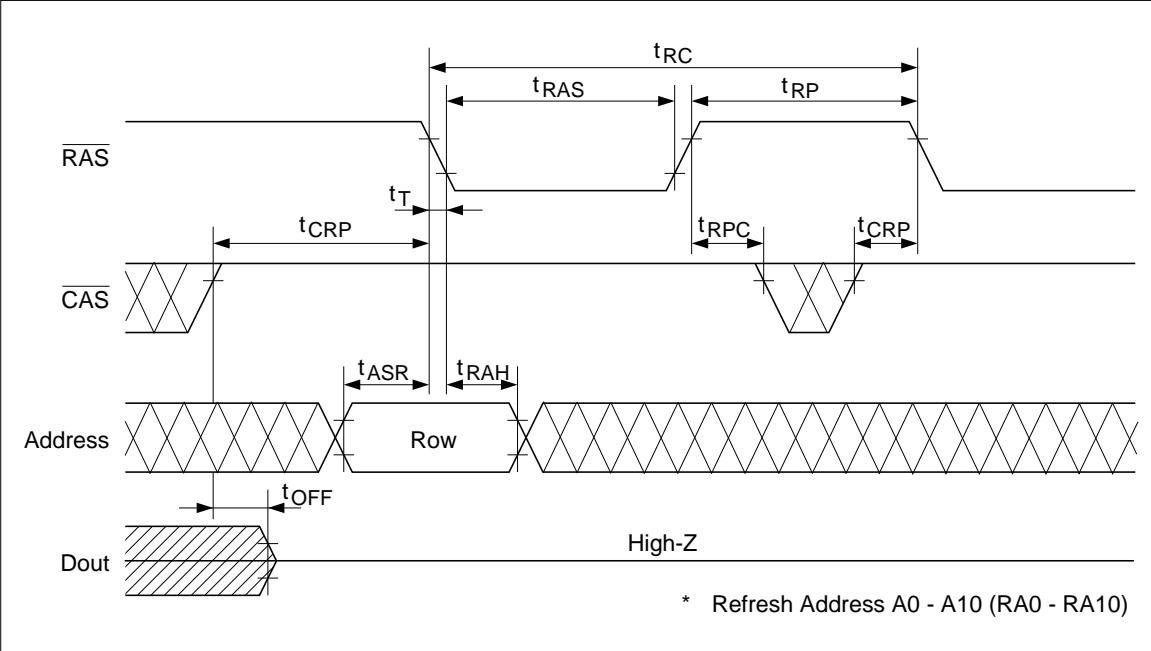


Test Mode Reset Cycle

CAS-Before-RAS Refresh Cycle



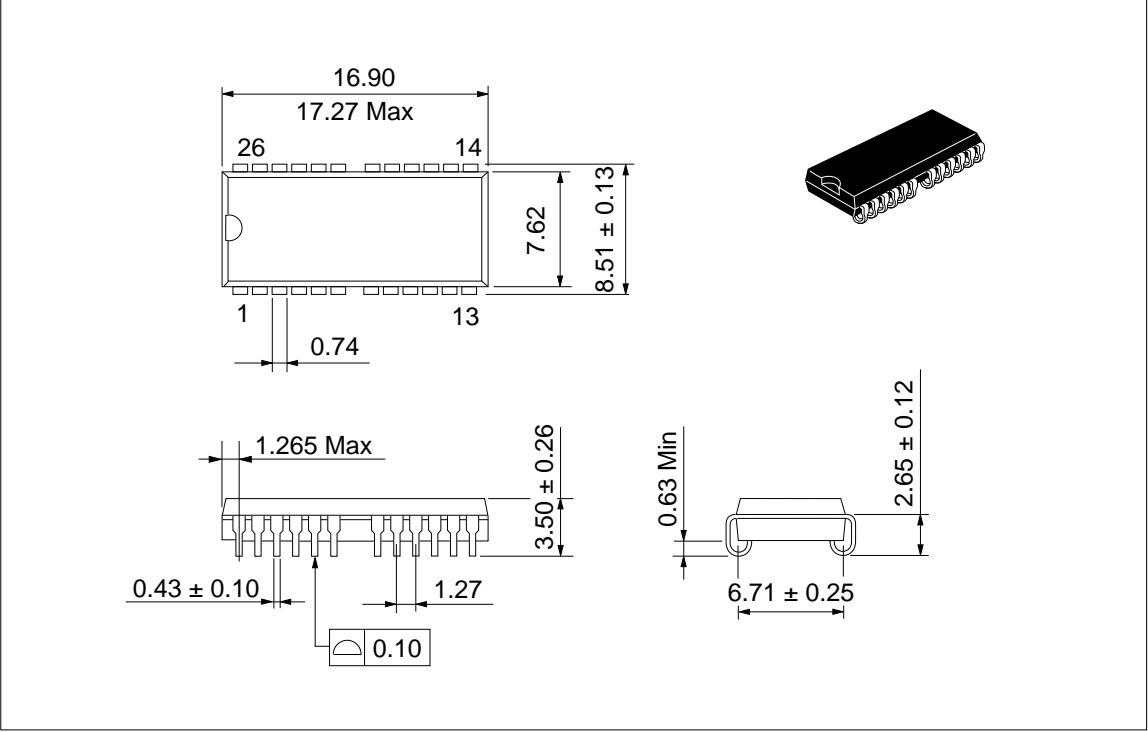
RAS-Only Refresh Cycle



Package Dimensions

HM5117400BS/BLS Series (CP-26/24DB)

Unit: mm



HM5117400BTS/BLTS Series (TTP-26/24DA)

Unit: mm

